

# PRODUCT SPECIFICATION

**Doc. Number:**

- ☐ Tentative Specification  
☐ Preliminary Specification  
☒ Approval Specification

**MODEL NO.: N140BGE**  
**SUFFIX: L32**

**Customer: for common model**

**APPROVED BY**

**SIGNATURE**

**Name / Title**

Please return 1 copy for your confirmation with your signature and comments.

Approved By	Checked By	Prepared By
楊竣傑	曹文彬	郭凡好
2013-03-22 08:50:46 CST	2013-03-21 14:00:32 CST	2013-03-15 13:01:31 CST

# PRODUCT SPECIFICATION

## CONTENTS

<b>1. GENERAL DESCRIPTION .....</b>	<b>4</b>
1.1 OVERVIEW .....	4
1.2 GENERAL SPECIFICATIONS .....	4
<b>2. MECHANICAL SPECIFICATIONS .....</b>	<b>4</b>
2.1 CONNECTOR TYPE .....	4
<b>3. ABSOLUTE MAXIMUM RATINGS .....</b>	<b>5</b>
3.1 ABSOLUTE RATINGS OF ENVIRONMENT .....	5
3.2 ELECTRICAL ABSOLUTE RATINGS .....	5
3.2.1 TFT LCD MODULE .....	5
<b>4. ELECTRICAL SPECIFICATIONS .....</b>	<b>6</b>
4.1 FUNCTION BLOCK DIAGRAM .....	6
4.2. INTERFACE CONNECTIONS .....	6
4.3 ELECTRICAL CHARACTERISTICS .....	8
4.3.1 LCD ELETRONICS SPECIFICATION .....	8
4.3.2 LED CONVERTER SPECIFICATION .....	10
4.3.3 BACKLIGHT UNIT .....	12
4.4 LVDS INPUT SIGNAL TIMING SPECIFICATIONS .....	13
4.4.1 LVDS DC SPECIFICATIONS .....	13
4.4.2 LVDS DATA FORMAT .....	13
4.4.3 COLOR DATA INPUT ASSIGNMENT .....	14
4.5 DISPLAY TIMING SPECIFICATIONS .....	15
4.6 POWER ON/OFF SEQUENCE .....	16
<b>5. OPTICAL CHARACTERISTICS .....</b>	<b>17</b>
5.1 TEST CONDITIONS .....	17
5.2 OPTICAL SPECIFICATIONS .....	17
<b>6. RELIABILITY TEST ITEM .....</b>	<b>20</b>
<b>7. PACKING .....</b>	<b>21</b>
7.1 MODULE LABEL .....	21
7.2 CARTON .....	22
7.3 PALLET .....	23
<b>8. PRECAUTIONS .....</b>	<b>24</b>
8.1 HANDLING PRECAUTIONS .....	24
8.2 STORAGE PRECAUTIONS .....	24
8.3 OPERATION PRECAUTIONS .....	24
Appendix. EDID DATA STRUCTURE .....	25
Appendix. OUTLINE DRAWING .....	28
Appendix. SYSTEM COVER DESIGN GUIDANCE .....	30

# PRODUCT SPECIFICATION

## REVISION HISTORY

Version	Date	Page	Description
3.0	Dec 14, 2011	All	Approval Spec Ver.3.0 was first issued.
3.1	Mar. 02,2013	21,30	Update Spec LOGO, Module Label, Design Guidance

## 1. GENERAL DESCRIPTION

### 1.1 OVERVIEW

N140BGE-L32 is a 14.0" (14.0" diagonal) TFT Liquid Crystal Display module with LED Backlight unit and 40 pins LVDS interface. This module supports 1366 x 768 HD mode and can display 262,144 colors.

The optimum viewing angle is at 6 o'clock direction.

### 1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	14.0" diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1366 x R.G.B. x 768	pixel	-
Pixel Pitch	0.2265 (H) x 0.2265 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	262,144	color	-
Transmissive Mode	Normally white	-	-
Surface Treatment	Hard coating (3H), Anti-Glare	-	-
Luminance, White	200	Cd/m2	
Power Consumption	Total 3.34W (Max.) @ cell ,0.7 W (Max.), BL 2.64 W (Max.)		(1)

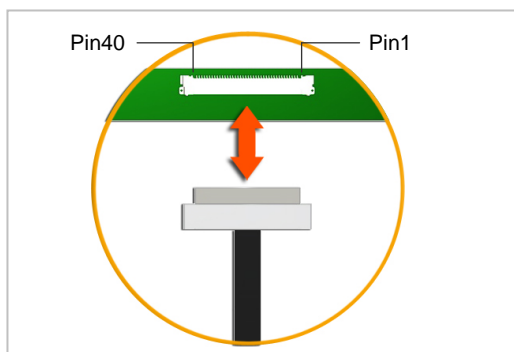
Note (1) The specified power consumption (with converter efficiency) is under the conditions at VCCS = 3.3 V,  $f_v = 60$  Hz, LED\_VCCS = Typ,  $f_{PWM} = 200$  Hz, Duty=100% and  $T_a = 25 \pm 2$  °C, whereas mosaic pattern is displayed.

## 2. MECHANICAL SPECIFICATIONS

Item	Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	319.9	320.4	320.9	mm
	Vertical (V)	204.6	205.1	205.6	mm
	Thickness (T)	-	-	3.6	mm
Active Area	Horizontal	309.099	309.399	309.699	mm
	Vertical	173.652	173.952	174.252	mm
Weight	-	310	320	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

### 2.1 CONNECTOR TYPE



Please refer Appendix Outline Drawing for detail design.

Connector Part No.: IPEX-20455-040E-12 & Foxconn-GS13401-1110A-7H or equivalent

User's connector Part No: IPEX-20453-040T-01 or equivalent

# PRODUCT SPECIFICATION

## 3. ABSOLUTE MAXIMUM RATINGS

### 3.1 ABSOLUTE RATINGS OF ENVIRONMENT

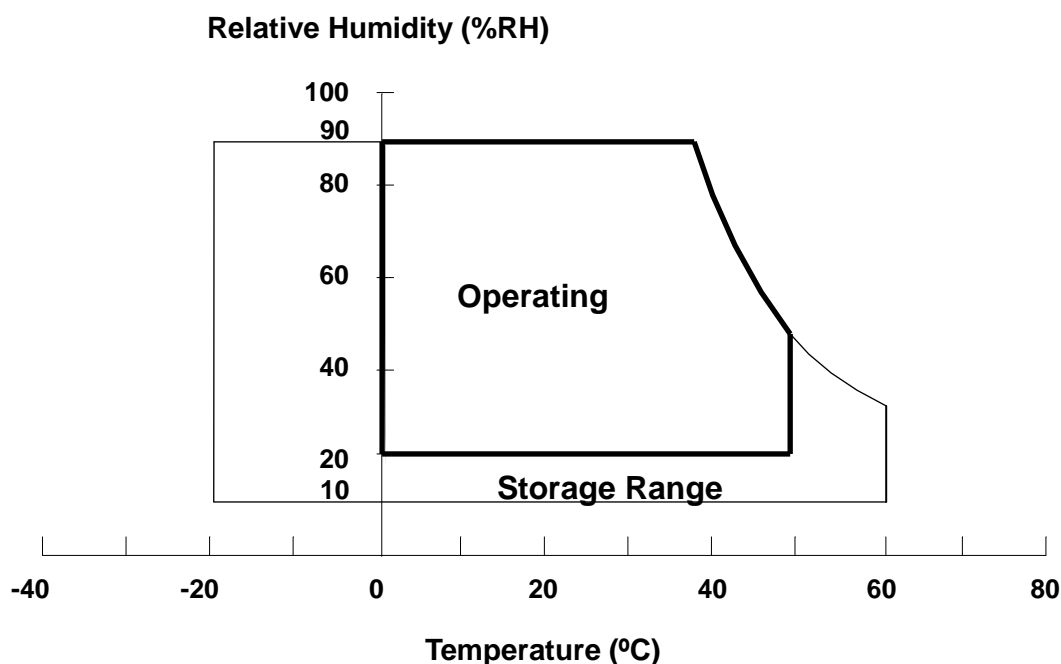
Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	T <sub>ST</sub>	-20	+60	°C	(1)
Operating Ambient Temperature	T <sub>OP</sub>	0	+50	°C	(1), (2)

Note (1) (a) 90 %RH Max. (Ta ≤ 40 °C).

(b) Wet-bulb temperature should be 39 °C Max. (Ta > 40 °C).

(c) No condensation.

Note (2) The temperature of panel surface should be 0 °C min. and 60 °C max.



## 3.2 ELECTRICAL ABSOLUTE RATINGS

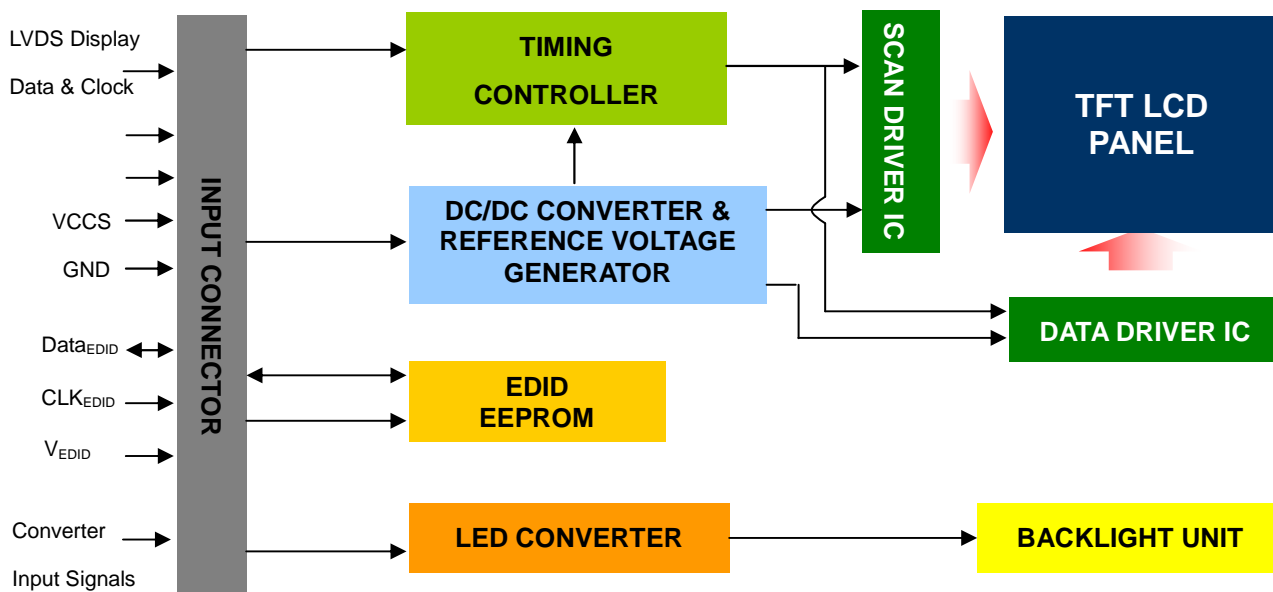
### 3.2.1 TFT LCD MODULE

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	VCCS	-0.3	+4.0	V	(1)
Logic Input Voltage	V <sub>IN</sub>	-0.3	VCCS+0.3	V	
Converter Input Voltage	LED_VCCS	-0.3	25.0	V	(1)
Converter Control Signal Voltage	LED_PWM,	-0.3	3.6	V	(1)
Converter Control Signal Voltage	LED_EN	-0.3	3.6	V	(1)

Note (1) Stresses beyond those listed in above “ELECTRICAL ABSOLUTE RATINGS” may cause permanent damage to the device. Normal operation should be restricted to the conditions described in “ELECTRICAL CHARACTERISTICS”.

## 4. ELECTRICAL SPECIFICATIONS

### 4.1 FUNCTION BLOCK DIAGRAM



### 4.2. INTERFACE CONNECTIONS

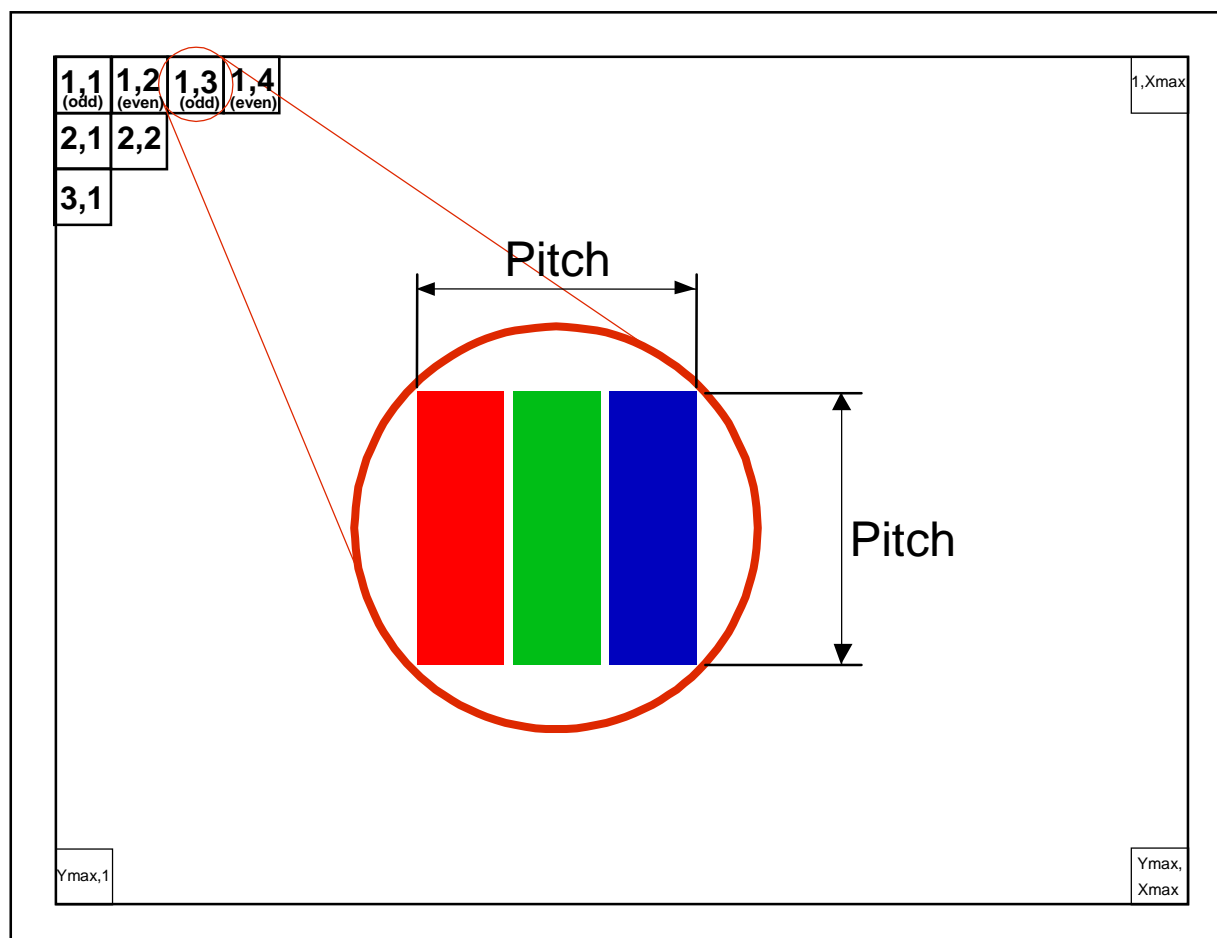
#### PIN ASSIGNMENT

Pin	Symbol	Description	Remark
1	NC	No Connection (Reserve)	
2	VCCS	Power Supply (3.3V typ.)	
3	VCCS	Power Supply (3.3V typ.)	
4	VEDID	DDC 3.3V power	
5	NC	No Connection (Reserved for INNOLUX test)	
6	CLKEDID	DDC clock	
7	DATAEDID	DDC data	
8	Rxin0-	LVDS differential data input	R0-R5, G0
9	Rxin0+	LVDS differential data input	
10	VSS	Ground	
11	Rxin1-	LVDS differential data input	G1~G5, B0, B1
12	Rxin1+	LVDS differential data input	
13	VSS	Ground	
14	Rxin2-	LVDS Differential Data Input	B2-B5,HS,VS, DE
15	Rxin2+	LVDS Differential Data Input	
16	VSS	Ground	
17	RxCLK-	LVDS differential clock input	LVDS CLK
18	RxCLK+	LVDS differential clock input	
19	VSS	Ground	
20	NC	No Connection (Reserve)	
21	NC	No Connection (Reserve)	
22	VSS	Ground	

## PRODUCT SPECIFICATION

23	NC	No Connection (Reserve)	
24	NC	No Connection (Reserve)	
25	VSS	Ground	
26	NC	No Connection (Reserve)	
27	NC	No Connection (Reserve)	
28	VSS	Ground	
29	NC	No Connection (Reserve)	
30	NC	No Connection (Reserve)	
31	LED_GND	LED Ground	
32	LED_GND	LED Ground	
33	LED_GND	LED Ground	
34	NC	No Connection (Reserve)	
35	LED_PWM	PWM Control Signal of LED Converter	
36	LED_EN	Enable Control Signal of LED Converter	
37	NC	No Connection (Reserve)	
38	LED_VCCS	LED Power Supply	
39	LED_VCCS	LED Power Supply	
40	LED_VCCS	LED Power Supply	

Note (1) The first pixel is odd as shown in the following figure.



# PRODUCT SPECIFICATION

## 4.3 ELECTRICAL CHARACTERISTICS

### 4.3.1 LCD ELETRONICS SPECIFICATION

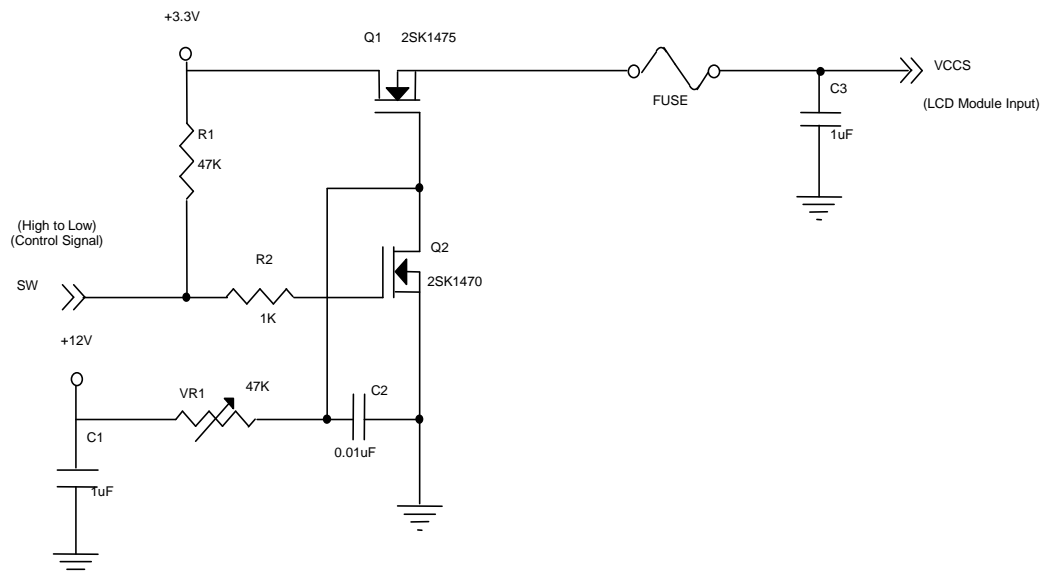
Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Power Supply Voltage		V <sub>CCS</sub>	3.0	3.3	3.6	V	(1)
Ripple Voltage		V <sub>RP</sub>	-	50	-	mV	(1)
Inrush Current		I <sub>RUSH</sub>	-	-	1.5	A	(1),(2)
Power Supply Current	Mosaic	I <sub>CC</sub>	130	145	160	mA	(3)a
	Black		120	135	150	mA	(3)b

Note (1) The ambient temperature is  $T_a = 25 \pm 2^\circ\text{C}$ .

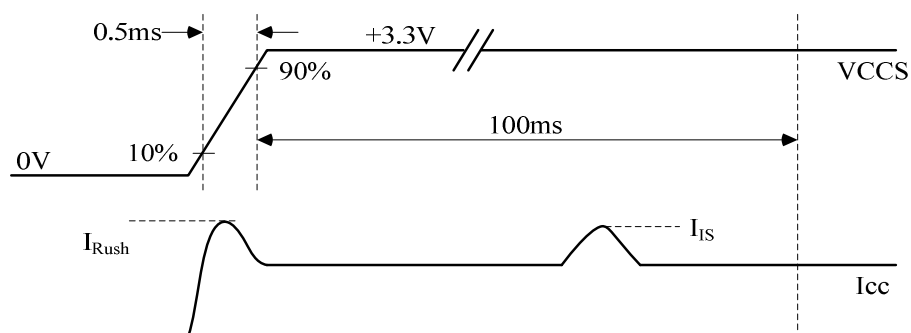
Note (2) I<sub>RUSH</sub>: the maximum current when VCCS is rising

I<sub>IS</sub>: the maximum current of the first 100ms after power-on

Measurement Conditions: Shown as the following figure. Test pattern: black.



**VCCS rising time is 0.5ms**

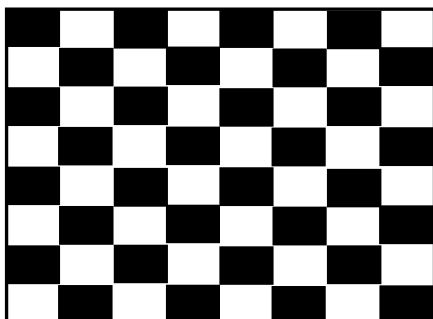




## PRODUCT SPECIFICATION

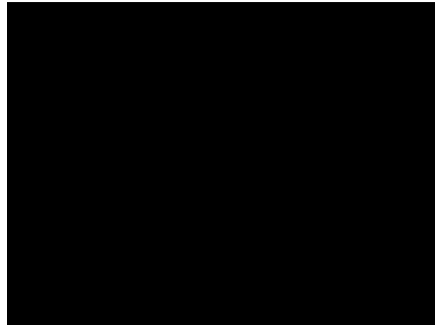
Note (3) The specified power supply current is under the conditions at  $V_{CCS} = 3.3\text{ V}$ ,  $T_a = 25 \pm 2\text{ }^{\circ}\text{C}$ , DC Current and  $f_v = 60\text{ Hz}$ , whereas a power dissipation check pattern below is displayed.

a. Mosaic Pattern



Active Area

b. Black Pattern



Active Area

# PRODUCT SPECIFICATION

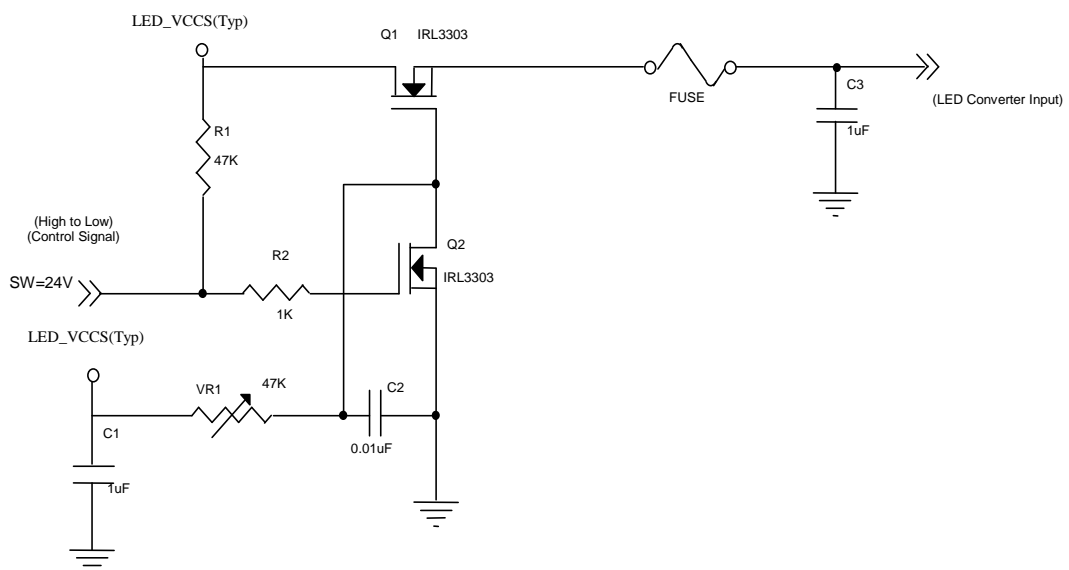
## 4.3.2 LED CONVERTER SPECIFICATION

Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Converter Input power supply voltage		LED_Vccs	6.0	12.0	21.0	V	
Converter Inrush Current		I <sub>LED_RUSH</sub>	-	-	1.5	A	(1)
EN Control Level	Backlight On		2.3	-	3.6	V	
	Backlight Off		0	-	0.5	V	
PWM Control Level	PWM High Level		2.3	-	3.6	V	
	PWM Low Level		0	-	0.5	V	
PWM Control Duty Ratio			10	-	100	%	
			5	-	100	%	(2)
PWM Control Permissive Ripple Voltage		V <sub>PWM_pp</sub>	-	-	100	mV	
PWM Control Frequency		f <sub>PWM</sub>	190	-	2K	Hz	(3)
LED Power Current	LED_VCCS =Typ.	I <sub>LED</sub>	163	200	220	mA	(4)

Note (1) I<sub>LED\_RUSH</sub>: the maximum current when LED\_VCCS is rising,

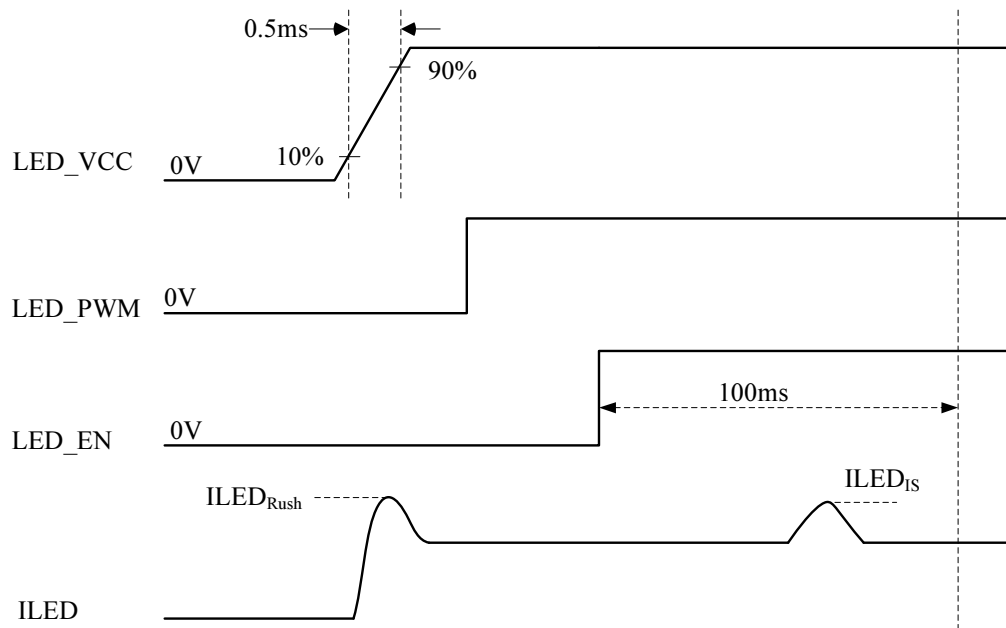
I<sub>LED\_IS</sub>: the maximum current of the first 100ms after power-on,

Measurement Conditions: Shown as the following figure. LED\_VCCS = Typ, Ta = 25 ± 2 °C, f<sub>PWM</sub> = 200 Hz, Duty=100%.



# PRODUCT SPECIFICATION

## VLED rising time is 0.5ms



Note (2) If the PWM control duty ratio is less than 10%, there is some possibility that acoustic noise or backlight flash can be found. And it is also difficult to control the brightness linearity.

Note (3) If PWM control frequency is applied in the range less than 1KHz, the “waterfall” phenomenon on the screen may be found. To avoid the issue, it's a suggestion that PWM control frequency should follow the criterion as below.

PWM control frequency  $f_{PWM}$  should be in the range

$$(N + 0.33) * f \leq f_{PWM} \leq (N + 0.66) * f$$

$N$  : Integer ( $N \geq 3$ )

$f$  : Frame rate

Note (4) The specified LED power supply current is under the conditions at “LED\_VCCS = Typ.”,  $T_a = 25 \pm 2 \text{ }^\circ\text{C}$ ,  $f_{PWM} = 200 \text{ Hz}$ , Duty=100%.

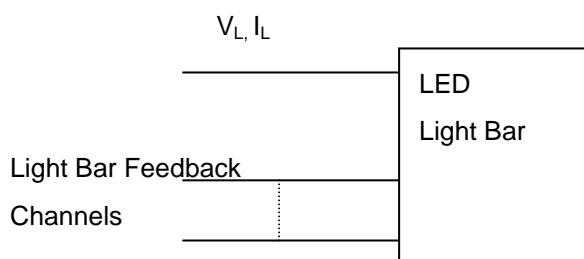
# PRODUCT SPECIFICATION

## 4.3.3 BACKLIGHT UNIT

$T_a = 25 \pm 2 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
LED Light Bar Power Supply Voltage	$V_L$	27.5	30.8	33	V	(1)(2)(Duty100%)
LED Light Bar Power Supply Current	$I_L$	62.7	66	69.3	mA	
Power Consumption	$P_L$	1.72	2.03	2.28	W	(3)
LED Life Time	$L_{BL}$	15000	-	-	Hrs	(4)

Note (1) LED current is measured by utilizing a high frequency current meter as shown below :



Note (2) For better LED light bar driving quality, it is recommended to utilize the adaptive boost converter with current balancing function to drive LED light-bar.

Note (3)  $P_L = I_L \times V_L$  (Without LED converter transfer efficiency)

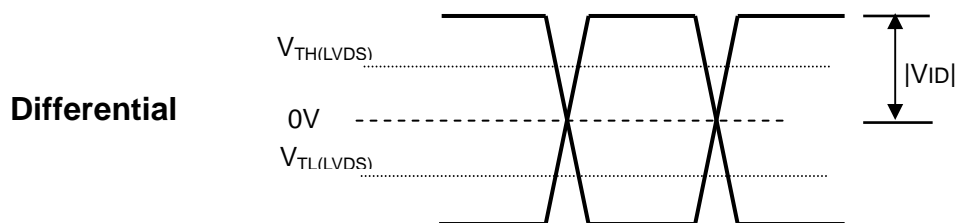
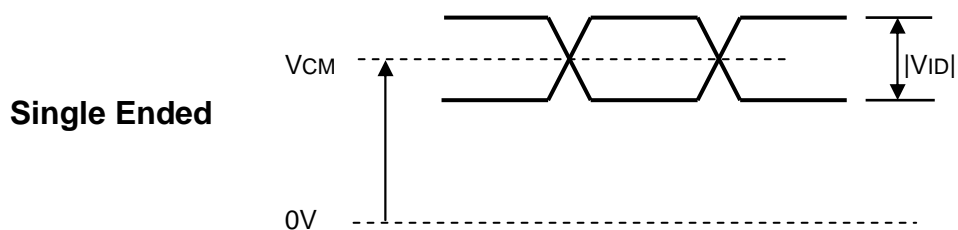
Note (4) The lifetime of LED is defined as the time when it continues to operate under the conditions at  $T_a = 25 \pm 2 \text{ }^{\circ}\text{C}$  and  $I_L = 22 \text{ mA}$ (Per EA) until the brightness becomes  $\leq 50\%$  of its original value.

## 4.4 LVDS INPUT SIGNAL TIMING SPECIFICATIONS

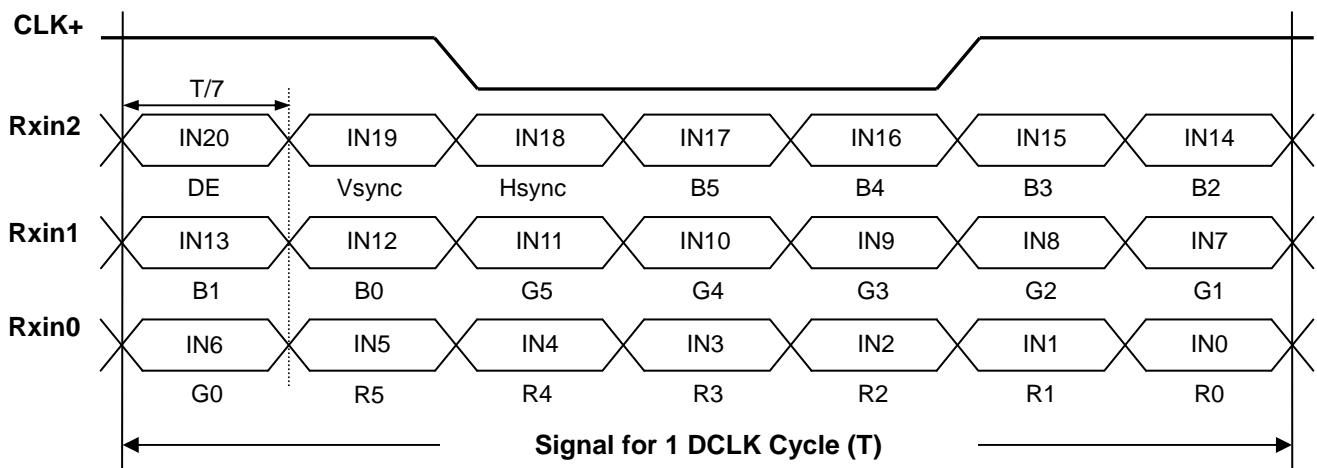
### 4.4.1 LVDS DC SPECIFICATIONS

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
LVDS Differential Input High Threshold	$V_{TH(LVDS)}$	-	-	+100	mV	(1), $V_{CM}=1.2V$
LVDS Differential Input Low Threshold	$V_{TL(LVDS)}$	-100	-	-	mV	(1), $V_{CM}=1.2V$
LVDS Common Mode Voltage	$V_{CM}$	1.125	-	1.375	V	(1)
LVDS Differential Input Voltage	$ V_{ID} $	100	-	600	mV	(1)
LVDS Terminating Resistor	$R_T$		100		Ohm	-

Note (1) The parameters of LVDS signals are defined as the following figures.



### 4.4.2 LVDS DATA FORMAT



# PRODUCT SPECIFICATION

## 4.4.3 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

Color		Data Signal																	
		Red						Green						Blue					
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
Gray Scale Of Green	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(61)	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
	Green(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0	
Gray Scale Of Blue	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	

Note (1) 0: Low Level Voltage, 1: High Level Voltage

# PRODUCT SPECIFICATION

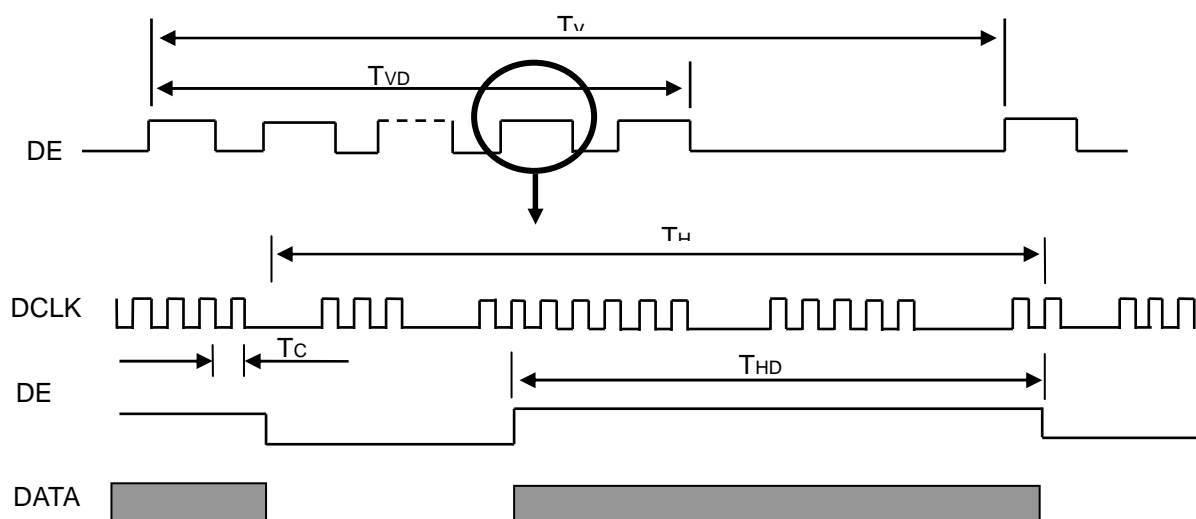
## 4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
DCLK	Frequency	1/Tc	45	69.3	77	MHz	-
DE	Vertical Total Time	TV	780	788	798	TH	-
	Vertical Active Display Period	TVD	768	768	768	TH	-
	Vertical Active Blanking Period	TVB	TV-TVD	20	TV-TVD	TH	-
	Horizontal Total Time	TH	1456	1466	1476	Tc	-
	Horizontal Active Display Period	THD	1366	1366	1366	Tc	-
	Horizontal Active Blanking Period	THB	TH-THD	100	TH-THD	Tc	-

Note (1) Because this module is operated by DE only mode, Hsync and Vsync are ignored.

### INPUT SIGNAL TIMING DIAGRAM

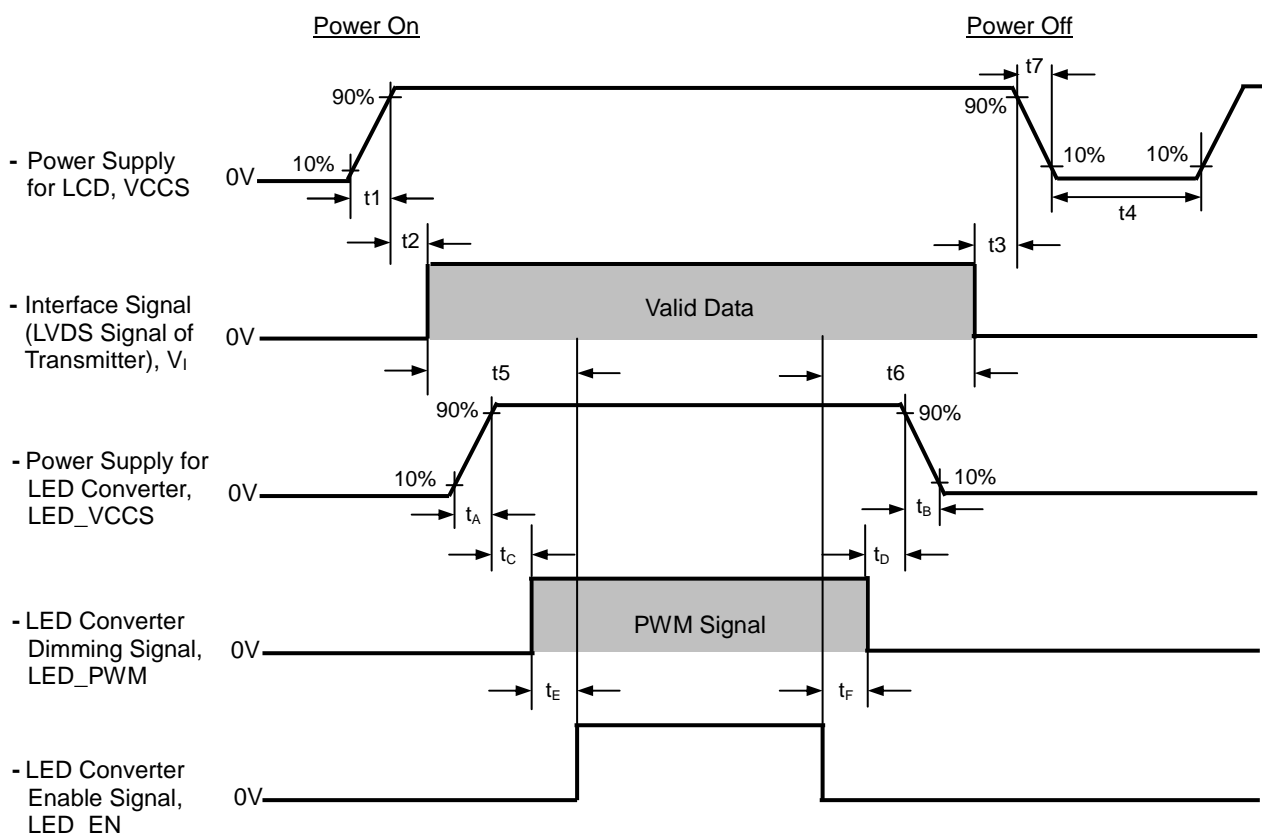


# PRODUCT SPECIFICATION

## 4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.

Symbol	Value			Unit	Note
	Min.	Typ.	Max.		
t1	0.5	-	10	ms	
t2	0	-	50	ms	
t3	0	-	50	ms	
t4	500	-	-	ms	
t5	200	-	-	ms	
t6	200	-	-	ms	
t7	0.5	-	10	ms	
t <sub>A</sub>	0.5	-	10	ms	
t <sub>B</sub>	0	-	10	ms	
t <sub>C</sub>	10	-	-	ms	
t <sub>D</sub>	10	-	-	ms	
t <sub>E</sub>	10	-	-	ms	
t <sub>F</sub>	10	-	-	ms	



Note (1) Please don't plug or unplug the interface cable when system is turned on.

Note (2) Please avoid floating state of the interface signal during signal invalid period.

Note (3) It is recommended that the backlight power must be turned on after the power supply for LCD and the interface signal is valid.



# PRODUCT SPECIFICATION

## 5. OPTICAL CHARACTERISTICS

### 5.1 TEST CONDITIONS

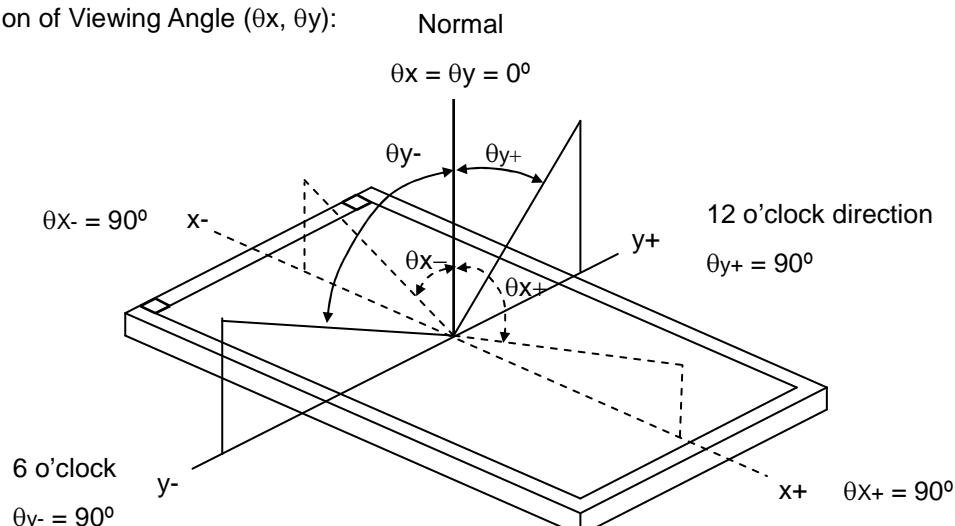
Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	Ha	50±10	%RH
Supply Voltage	V <sub>CC</sub>	3.3	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Light Bar Input Current	I <sub>L</sub>	66	mA

The measurement methods of optical characteristics are shown in Section 5.2. The following items should be measured under the test conditions described in Section 5.1 and stable environment shown in Note (5).

### 5.2 OPTICAL SPECIFICATIONS

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note	
Contrast Ratio		CR	$\theta_x=0^\circ, \theta_Y=0^\circ$ Viewing Normal Angle	300	500	-	-	(2), (5) (7)	
Response Time		T <sub>R</sub>		-	4	8	ms	(3),(7)	
		T <sub>F</sub>		-	6	12	ms		
Average Luminance of White		L <sub>Ave</sub>		170	200	-	cd/m <sup>2</sup>	(4), (6),(7)	
Color Chromaticity	Red	R <sub>x</sub>		Typ – 0.03	0.590 0.342 0.330 0.562 0.160 0.140 0.313 0.329	Typ + 0.03	-	(1),(7)	
		R <sub>y</sub>					-		
	Green	G <sub>x</sub>					-		
		G <sub>y</sub>					-		
	Blue	B <sub>x</sub>					-		
		B <sub>y</sub>					-		
	White	W <sub>x</sub>					-		
		W <sub>y</sub>					-		
Viewing Angle	Horizontal	$\theta_x+$	CR≥10	40	45	-	Deg.	(1),(5), (7)	
		$\theta_x-$		40	45				
	Vertical	$\theta_Y+$		15	20				-
		$\theta_Y-$		40	45				-
White Variation of 5 Points		δW <sub>5p</sub>	$\theta_x=0^\circ, \theta_Y=0^\circ$	80	-	-	%	(5),(6), (7)	

Note (1) Definition of Viewing Angle ( $\theta_x, \theta_y$ ):



# PRODUCT SPECIFICATION

Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

$$\text{Contrast Ratio (CR)} = L_{63} / L_0$$

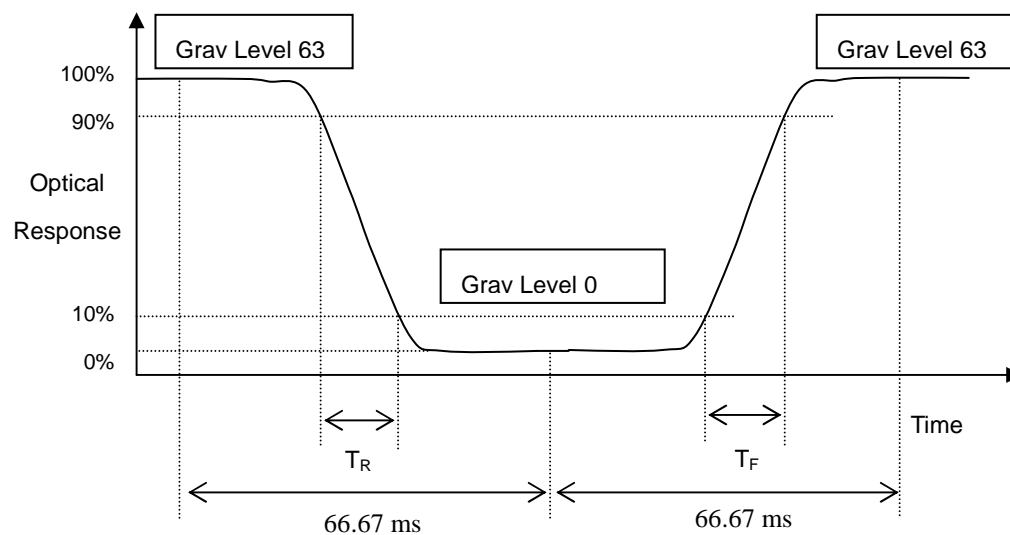
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

$$CR = CR (1)$$

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time ( $T_R$ ,  $T_F$ ):



Note (4) Definition of Average Luminance of White ( $L_{AVE}$ ):

Measure the luminance of White at 5 points

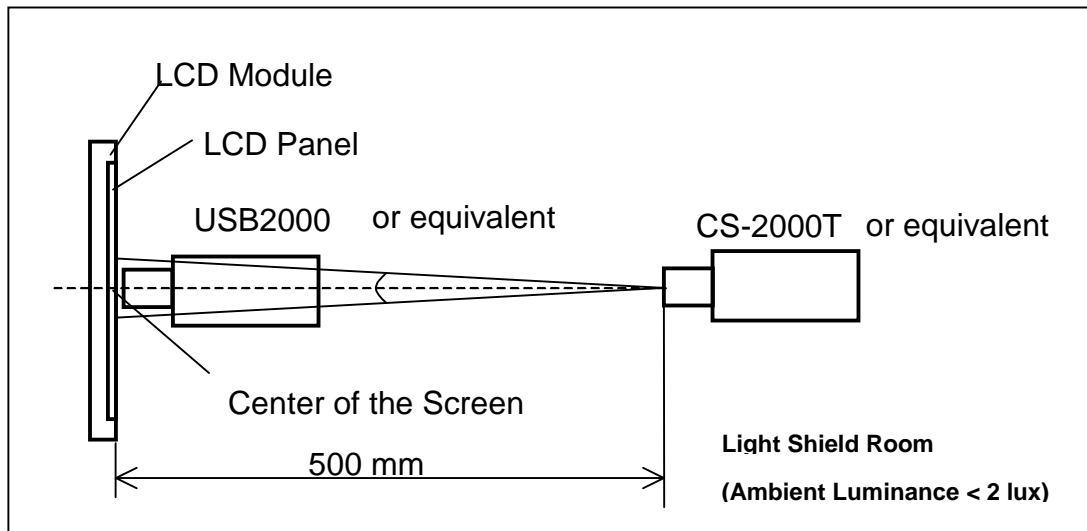
$$L_{AVE} = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5$$

L (x) is corresponding to the luminance of the point X at Figure in Note (6)

# PRODUCT SPECIFICATION

## Note (5) Measurement Setup:

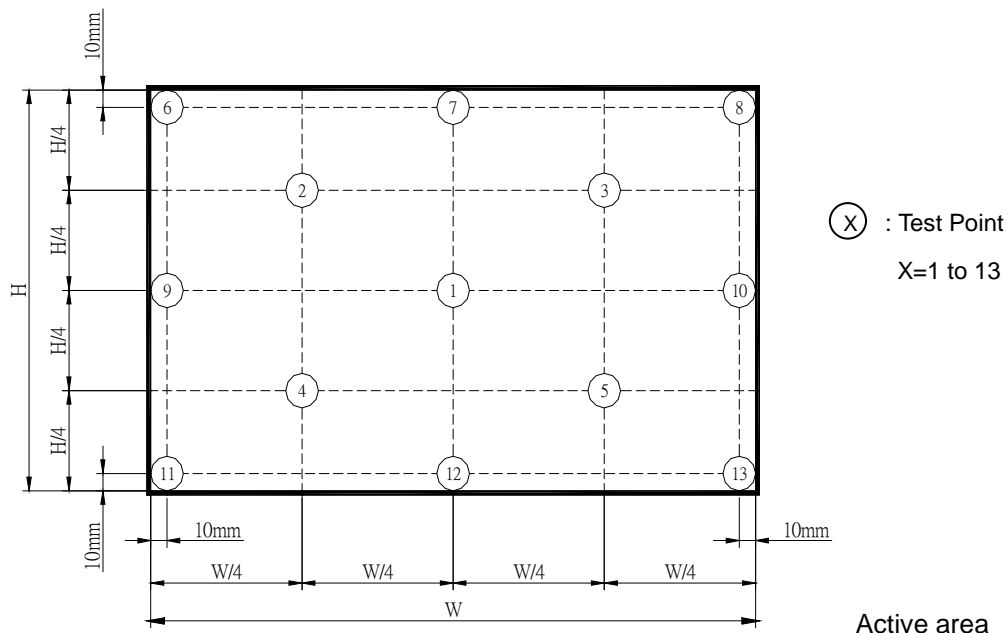
The LCD module should be stabilized at given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



## Note (6) Definition of White Variation ( $\delta W$ ):

Measure the luminance of White at 5 points

$$\delta W_{5p} = \{ \text{Minimum} [L(1) \sim L(5)] / \text{Maximum} [L(1) \sim L(5)] \} * 100\%$$



Note (7) The listed optical specifications refer to the initial value of manufacture, but the condition of the specifications after long-term operation will not be warranted.

## PRODUCT SPECIFICATION

### 6. RELIABILITY TEST ITEM

Test Item	Test Condition	Note
High Temperature Storage Test	60°C, 240 hours	(1) (2)
Low Temperature Storage Test	-20°C, 240 hours	
Thermal Shock Storage Test	-20°C, 0.5hour $\longleftrightarrow$ 60°C, 0.5hour; 100cycles, 1hour/cycle	
High Temperature Operation Test	50°C, 240 hours	
Low Temperature Operation Test	0°C, 240 hours	
High Temperature & High Humidity Operation Test	50°C, 80% RH, 240 hours	
ESD Test (Operation)	150pF, 330 $\Omega$ , 1sec/cycle Condition 1 : Contact Discharge, $\pm$ 8KV Condition 2 : Air Discharge, $\pm$ 15KV	(1)
Shock (Non-Operating)	220G, 2ms, half sine wave, 1 time for each direction of $\pm$ X, $\pm$ Y, $\pm$ Z	(1)(3)
Vibration (Non-Operating)	1.5G / 10-500 Hz, Sine wave, 30 min/cycle, 1cycle for each X, Y, Z	(1)(3)

Note (1) criteria : Normal display image with no obvious non-uniformity and no line defect.

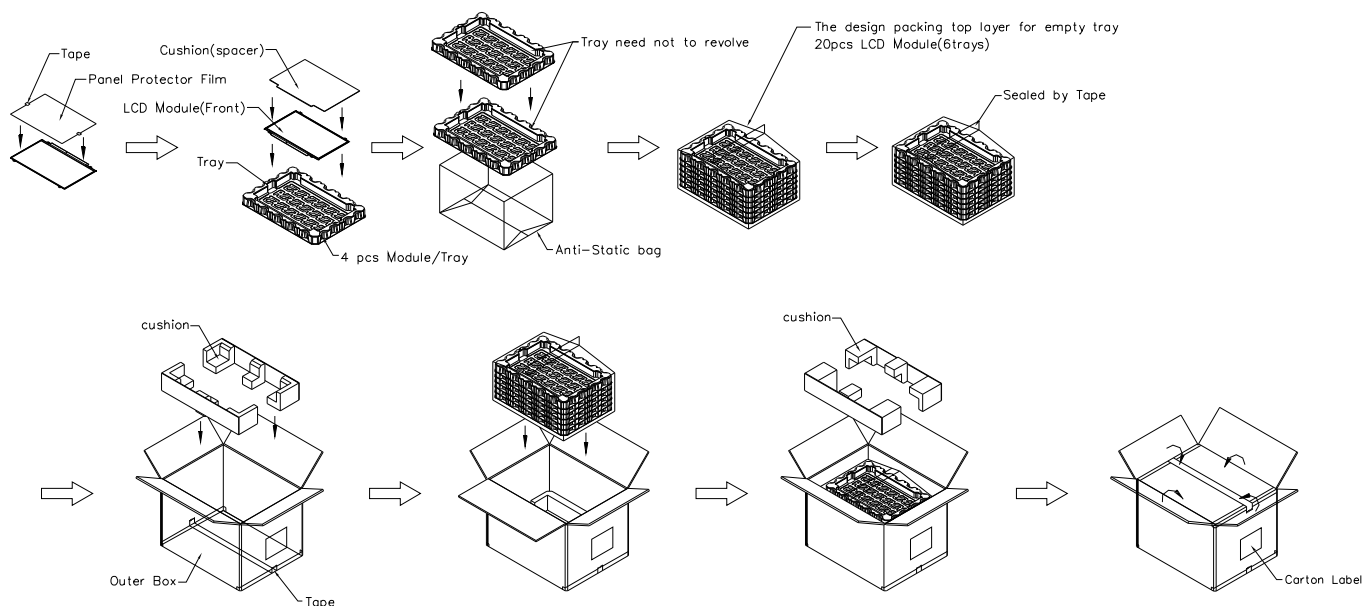
Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.



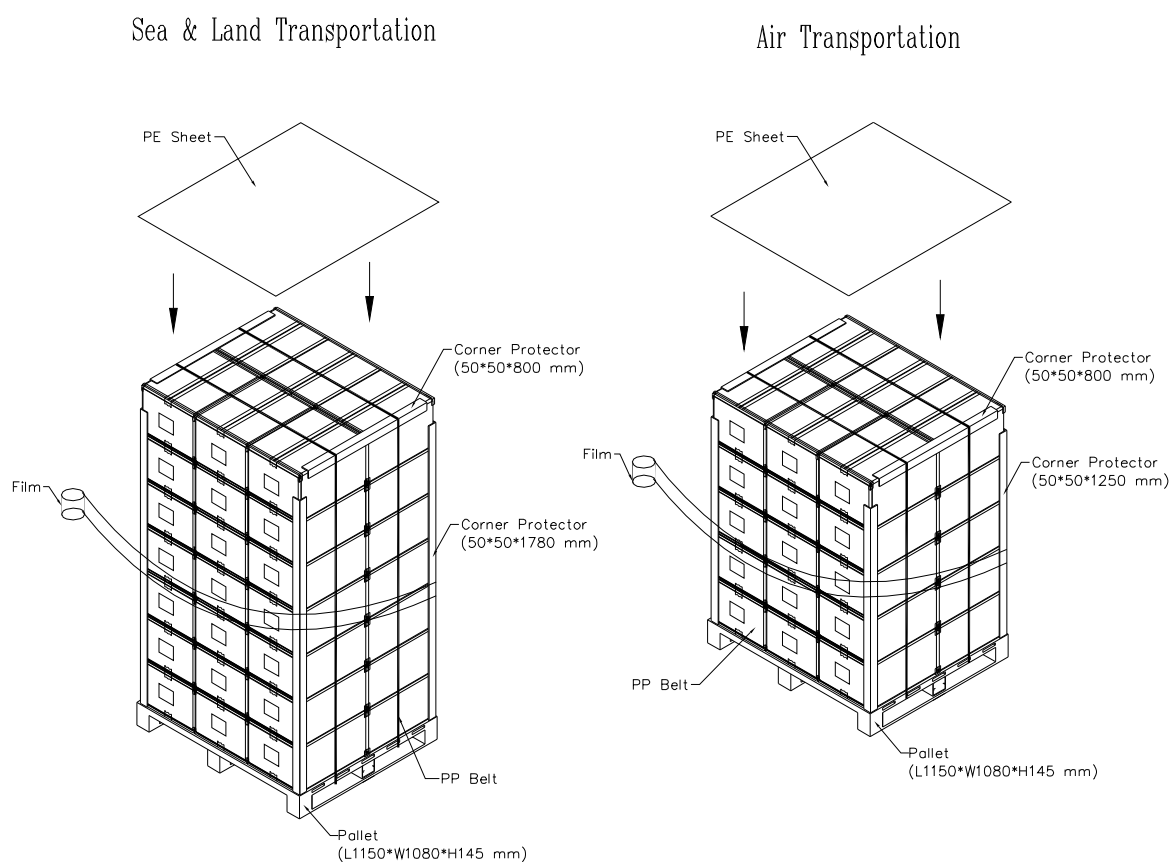
## 7.2 CARTON

Box Dimensions : 435(L)\*350(W)\*275(H)  
Weight : Approx. 8.09Kg (20 module .per. 1box)



**Figure. 7-2 Packing method**

## 7.3 PALLET



**Figure. 7-3 Packing method**

## 8. PRECAUTIONS

### 8.1 HANDLING PRECAUTIONS

- (1) The module should be assembled into the system firmly by using every mounting hole. Be careful not to twist or bend the module.
- (2) While assembling or installing modules, it can only be in the clean area. The dust and oil may cause electrical short or damage the polarizer.
- (3) Use fingerstalls or soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (4) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.
- (5) If the surface of the polarizer is dirty, please clean it by some absorbent cotton or soft cloth. Do not use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanently damage the polarizer due to chemical reaction.
- (6) Wipe off water droplets or oil immediately. Staining and discoloration may occur if they left on panel for a long time.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contacting with hands, legs or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static electricity, it may cause damage to the C-MOS Gate Array IC.
- (9) Do not disassemble the module.
- (10) Do not pull or fold the LED wire.
- (11) Pins of I/F connector should not be touched directly with bare hands.

### 8.2 STORAGE PRECAUTIONS

- (1) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (2) It is dangerous that moisture come into or contacted the LCD module, because the moisture may damage LCD module when it is operating.
- (3) It may reduce the display quality if the ambient temperature is lower than 10 °C. For example, the response time will become slowly, and the starting voltage of LED will be higher than the room temperature.

### 8.3 OPERATION PRECAUTIONS

- (1) Do not pull the I/F connector in or out while the module is operating.
- (2) Always follow the correct power on/off sequence when LCD module is connecting and operating. This can prevent the INXS LSI chips from damage during latch-up.
- (3) The startup voltage of Backlight is approximately 1000 Volts. It may cause electrical shock while assembling with converter. Do not disassemble the module or insert anything into the Backlight unit.



# PRODUCT SPECIFICATION

## Appendix. EDID DATA STRUCTURE

The EDID (Extended Display Identification Data) data formats are to support displays as defined in the VESA Plug & Display and FPD standards.

Byte # (decimal)	Byte # (hex)	Field Name and Comments	Value (hex)	Value (binary)
0	0	Header	00	00000000
1	1	Header	FF	11111111
2	2	Header	FF	11111111
3	3	Header	FF	11111111
4	4	Header	FF	11111111
5	5	Header	FF	11111111
6	6	Header	FF	11111111
7	7	Header	00	00000000
8	8	EISA ID manufacturer name ("CMN")	0D	00001101
9	9	EISA ID manufacturer name (Compressed ASCII)	AE	10101110
10	0A	ID product code (N140BGE-L32)	71	01110001
11	0B	ID product code (hex LSB first; N140BGE-L32)	14	00010100
12	0C	ID S/N (fixed "0")	00	00000000
13	0D	ID S/N (fixed "0")	00	00000000
14	0E	ID S/N (fixed "0")	00	00000000
15	0F	ID S/N (fixed "0")	00	00000000
16	10	Week of manufacture (fixed "00H")	23	00100011
17	11	Year of manufacture (fixed "00H")	15	00010101
18	12	EDID structure version # ("1")	01	00000001
19	13	EDID revision # ("3")	03	00000011
20	14	Video I/P definition ("digital")	80	10000000
21	15	Max H image size ("30.9cm")	1F	00011111
22	16	Max V image size ("17.4cm")	11	00010001
23	17	Display Gamma (Gamma = "2.2")	78	01111000
24	18	Feature support ("Active off, RGB Color")	0A	00001010
25	19	Red/Green (Rx1, Rx0, Ry1, Ry0, Gx1, Gx0, Gy1, Gy0)	D1	11010001
26	1A	Blue/White (Bx1, Bx0, By1, By0, Wx1, Wx0, Wy1, Wy0)	45	01000101
27	1B	Red-x (Rx = "0.608")	9B	10011011
28	1C	Red-y (Ry = "0.349")	59	01011001
29	1D	Green-x (Gx = "0.340")	57	01010111
30	1E	Green-y (Gy = "0.556")	8E	10001110
31	1F	Blue-x (Bx = "0.169")	2B	00101011
32	20	Blue-y (By = "0.137")	23	00100011
33	21	White-x (Wx = "0.313")	50	01010000
34	22	White-y (Wy = "0.329")	54	01010100
35	23	Established timings 1	00	00000000
36	24	Established timings 2	00	00000000
37	25	Manufacturer's reserved timings	00	00000000
38	26	Standard timing ID # 1	01	00000001
39	27	Standard timing ID # 1	01	00000001
40	28	Standard timing ID # 2	01	00000001

# PRODUCT SPECIFICATION

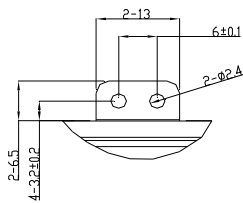
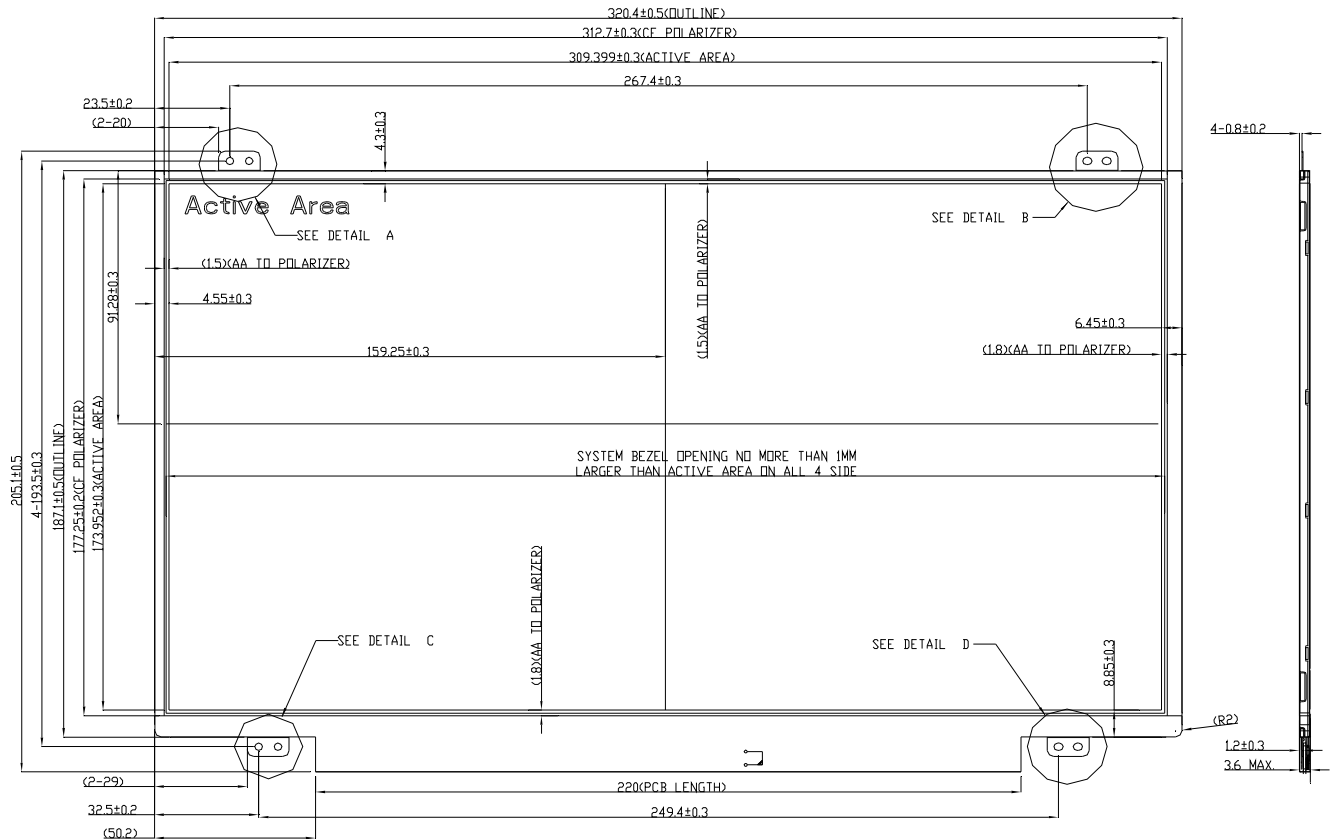
41	29	Standard timing ID # 2	01	00000001
42	2A	Standard timing ID # 3	01	00000001
43	2B	Standard timing ID # 3	01	00000001
44	2C	Standard timing ID # 4	01	00000001
45	2D	Standard timing ID # 4	01	00000001
46	2E	Standard timing ID # 5	01	00000001
47	2F	Standard timing ID # 5	01	00000001
48	30	Standard timing ID # 6	01	00000001
49	31	Standard timing ID # 6	01	00000001
50	32	Standard timing ID # 7	01	00000001
51	33	Standard timing ID # 7	01	00000001
52	34	Standard timing ID # 8	01	00000001
53	35	Standard timing ID # 8	01	00000001
54	36	Detailed timing description # 1 Pixel clock ("69.3MHz", According to VESA CVT Rev1.1)	12	00010010
55	37	# 1 Pixel clock (hex LSB first)	1B	00011011
56	38	# 1 H active ("1366")	56	01010110
57	39	# 1 H blank ("100")	64	01100100
58	3A	# 1 H active : H blank ("1366 : 100")	50	01010000
59	3B	# 1 V active ("768")	00	00000000
60	3C	# 1 V blank ("20")	14	00010100
61	3D	# 1 V active : V blank ("768 :20")	30	00110000
62	3E	# 1 H sync offset ("48")	30	00110000
63	3F	# 1 H sync pulse width ("32")	20	00100000
64	40	# 1 V sync offset : V sync pulse width ("1 : 4")	14	00010100
65	41	# 1 H sync offset : H sync pulse width : V sync offset : V sync width ("48: 32 : 1 : 4")	00	00000000
66	42	# 1 H image size ("309 mm")	35	00110101
67	43	# 1 V image size ("174 mm")	AE	10101110
68	44	# 1 H image size : V image size ("309 : 174")	10	00010000
69	45	# 1 H boarder ("0")	00	00000000
70	46	# 1 V boarder ("0")	00	00000000
71	47	# 1 Non-interlaced, Normal, no stereo, Separate sync, H/V pol Negatives	18	00011000
72	48	Detailed timing description # 2	00	00000000
73	49	# 2 Flag	00	00000000
74	4A	# 2 Reserved	00	00000000
75	4B	# 2 FE (hex) defines ASCII string (Model Name "N140BGE-L32", ASCII)	FE	11111110
76	4C	# 2 Flag	00	00000000
77	4D	# 2 1st character of name ("N")	4E	01001110
78	4E	# 2 2nd character of name ("1")	31	00110001
79	4F	# 2 3rd character of name ("4")	34	00110100
80	50	# 2 4th character of name ("0")	30	00110000
81	51	# 2 5th character of name ("B")	42	01000010
82	52	# 2 6th character of name ("G")	47	01000111
83	53	# 2 7th character of name ("E")	45	01000101
84	54	# 2 8th character of name ("-")	2D	00101101

## PRODUCT SPECIFICATION

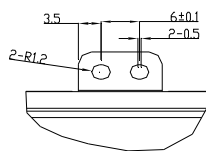
85	55	# 2 9th character of name ("L")	4C	01001100
86	56	# 2 9th character of name ("3")	33	00110011
87	57	# 2 Ath character of name ("2")	32	00110010
88	58	# 2 New line character indicates end of ASCII string	0A	00001010
89	59	# 2 Padding with "Blank" character	20	00100000
90	5A	Detailed timing description # 3	00	00000000
91	5B	# 3 Flag	00	00000000
92	5C	# 3 Reserved	00	00000000
93	5D	# 3 FE (hex) defines ASCII string (Vendor "INX", ASCII)	FE	11111110
94	5E	# 3 Flag	00	00000000
95	5F	# 3 1st character of string ("C")	43	01000011
96	60	# 3 2nd character of string ("M")	4D	01001101
97	61	# 3 3rd character of string ("N")	4E	01001110
98	62	# 3 New line character indicates end of ASCII string	0A	00001010
99	63	# 3 Padding with "Blank" character	20	00100000
100	64	# 3 Padding with "Blank" character	20	00100000
101	65	# 3 Padding with "Blank" character	20	00100000
102	66	# 3 Padding with "Blank" character	20	00100000
103	67	# 3 Padding with "Blank" character	20	00100000
104	68	# 3 Padding with "Blank" character	20	00100000
105	69	# 3 Padding with "Blank" character	20	00100000
106	6A	# 3 Padding with "Blank" character	20	00100000
107	6B	# 3 Padding with "Blank" character	20	00100000
108	6C	Detailed timing description # 4	00	00000000
109	6D	# 4 Flag	00	00000000
110	6E	# 4 Reserved	00	00000000
111	6F	# 4 FE (hex) defines ASCII string (Model Name"N140BGE-L32", ASCII)	FE	11111110
112	70	# 4 Flag	00	00000000
113	71	# 4 1st character of name ("N")	4E	01001110
114	72	# 4 2nd character of name ("1")	31	00110001
115	73	# 4 3rd character of name ("4")	34	00110100
116	74	# 4 4th character of name ("0")	30	00110000
117	75	# 4 5th character of name ("B")	42	01000010
118	76	# 4 6th character of name ("G")	47	01000111
119	77	# 4 7th character of name ("E")	45	01000101
120	78	# 4 8th character of name ("-")	2D	00101101
121	79	# 4 9th character of name ("L")	4C	01001100
122	7A	# 4 9th character of name ("3")	33	00110011
123	7B	# 4 Ath character of name ("2")	32	00110010
124	7C	# 4 New line character indicates end of ASCII string	0A	00001010
125	7D	# 4 Padding with "Blank" character	20	00100000
126	7E	Extension flag	00	00000000
127	7F	Checksum	09	00001001

# PRODUCT SPECIFICATION

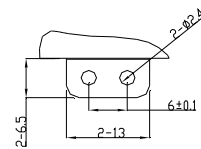
## Appendix. OUTLINE DRAWING



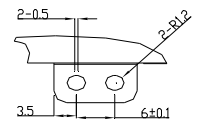
DETAIL A  
SCALE 2:1



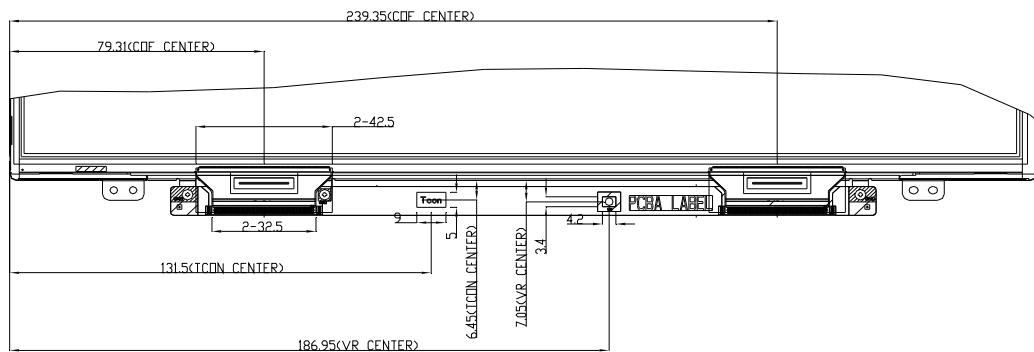
DETAIL B  
SCALE 2:1



DETAIL C  
SCALE 2:1

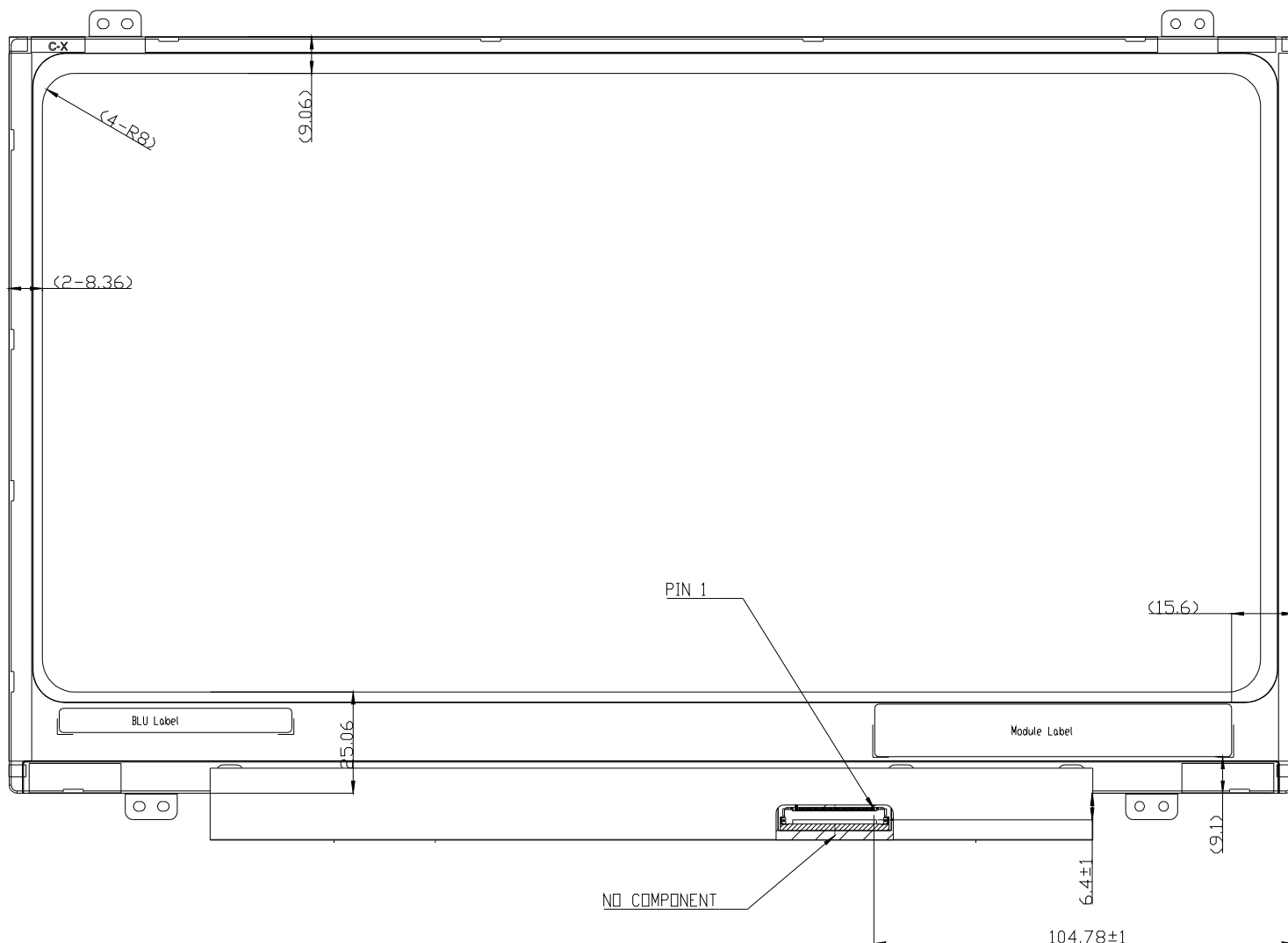


DETAIL D  
SCALE 2:1



COF, TCON AND VR LOCATIONS  
SEE NOTES FOR EXPLANATION

# PRODUCT SPECIFICATION



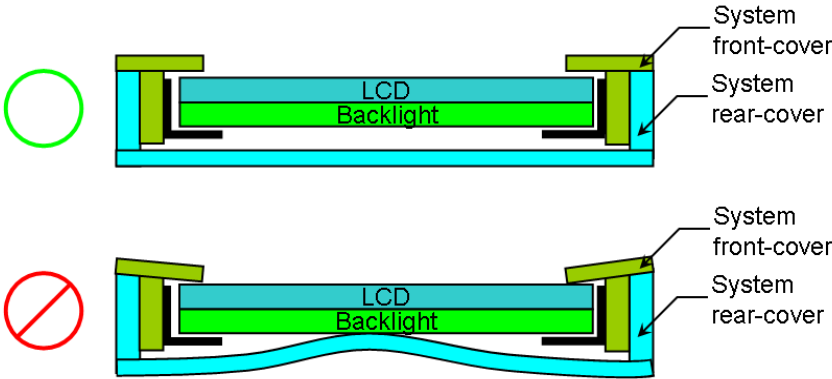
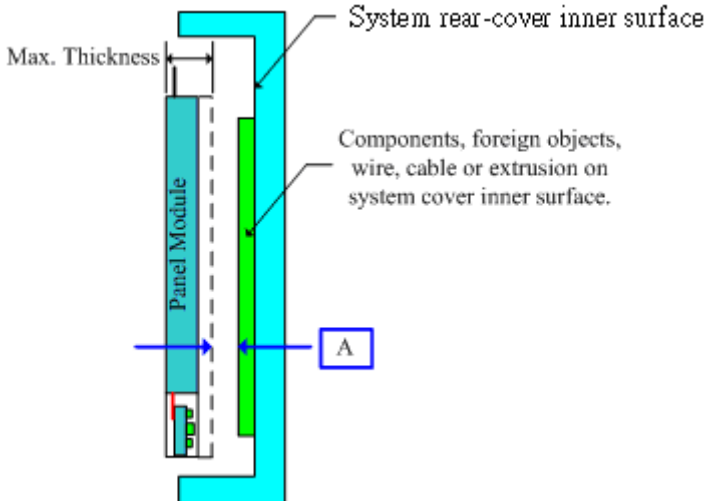
## NOTES:

1. LCD MODULE INPUT CONNECTOR : I-PEX 20455-040E-12
2. IN ORDER TO AVOID ABNORMAL DISPLAY, POOLING AND WHITE SPOT,  
NO OVERLAPPING IS SUGGESTED AT CABLES, ANTENNAS, CAMERA,  
WLAN, WAN OR  
FOREIGN OBJECTS OVER COF, T-CON AND VR LOCATIONS.
3. LVDS CONNECTOR IS MEASURED AT PIN1 AND ITS MATING LINE.
4. MODULE FLATNESS SPEC 0.5mm MAX.
5. "< >" MARKS THE REFERENCE DIMENSIONS.

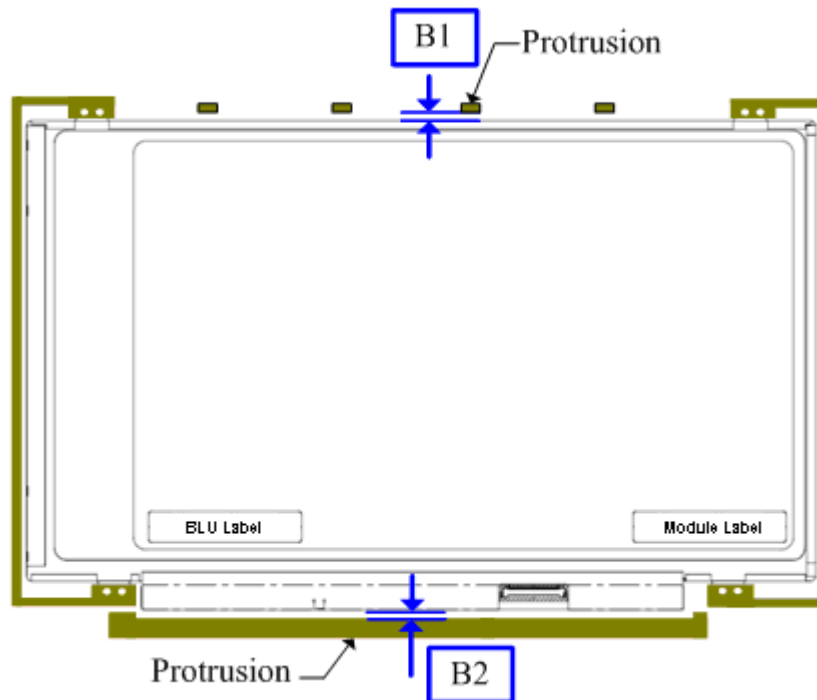
General Tolerance Unless Specified			
0-6	$\pm 0.1$	300-600	$\pm 0.3$
6-30	$\pm 0.15$	600-	$\pm 0.6$
30-300	$\pm 0.2$	ANGLE	$\pm 1.0^\circ$

# PRODUCT SPECIFICATION

## Appendix. SYSTEM COVER DESIGN GUIDANCE

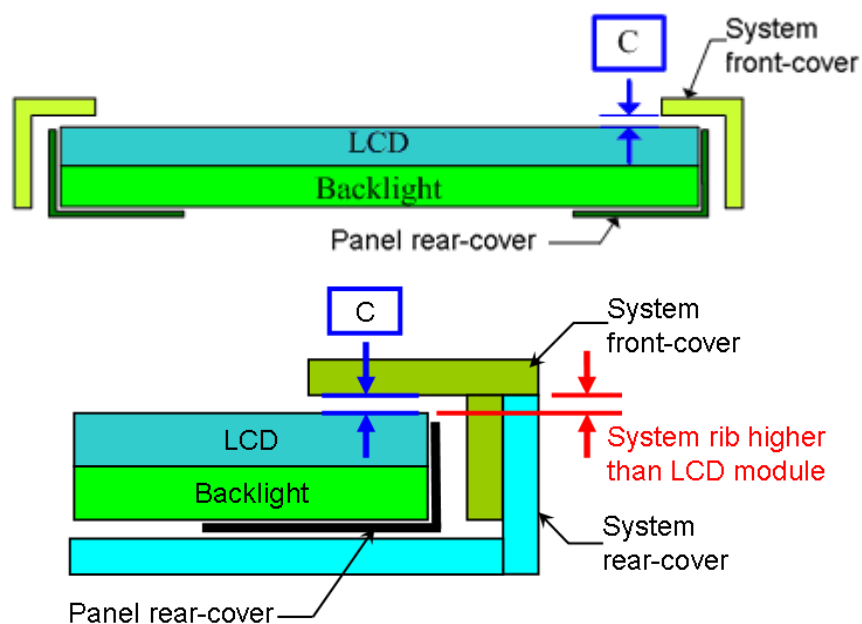
0.	Permanent deformation of system cover after reliability test
	
Definition	System cover including front and rear cover may deform during reliability test. Permanent deformation of system front and rear cover after reliability test should not interfere with panel. Because it may cause issues such as pooling, abnormal display, and also white spot.
1.	Design gap A between panel & any components on system rear-cover
	
Definition	<p>a). Sufficient gap between panel &amp; system is recommended for preventing from backpack or pogo test fail.</p> <p>b). Zero gap from panel's maximum thickness boundary to any components, foreign objects, wire, cable or extrusion on system cover inner surface is forbidden.</p> <p>c). Interference between panel and system rear-cover is forbidden after reliability test.</p> <p>Note: Recommend at least 0.6mm gap. If the gap is less than recommendation, please check with INX.</p>
2	Design gap B1 & B2 between panel & protrusions

## PRODUCT SPECIFICATION



Definition	<p>a). Sufficient gap is recommended between panel &amp; protrusions for preventing from shock related failures.</p> <p>b). Interference between panel and system rear-cover is forbidden after reliability test.</p> <p>Note: Recommend at least 2.0mm gap. If the gap is less than recommendation, please check with INX.</p>
------------	---

### 3 Design gap C between system front-cover & panel surface.



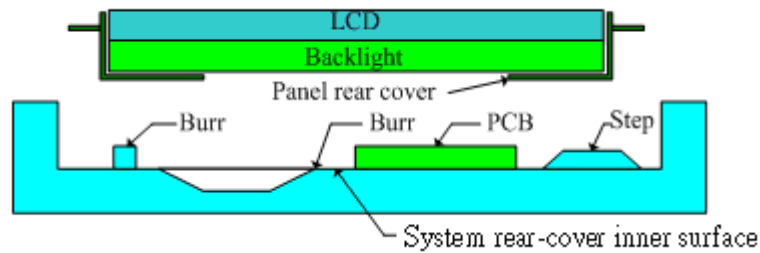
Definition	<p>a). Sufficient gap between system front-cover &amp; panel surface is a must for preventing from pooling or glass broken.</p> <p>b). Interference between panel and system (front &amp; rear) cover is forbidden after reliability</p>
------------	--

# PRODUCT SPECIFICATION

	<p>test.</p> <p>c). Interference is also forbidden in the act of system front-cover deformation during swing test, hinge test, knock test, or during pooling inspection procedure.</p> <p>d). To remain sufficient gap, design with system rib higher than maximum panel thickness is recommended.</p> <p>Note: Recommend at least 0.1mm gap. If the gap is less than recommendation, please check with INX.</p>
4	<p><b>Design gap D1 &amp; D2 between system front-cover &amp; PCB Assembly.</b></p> <div data-bbox="405 553 1216 797" data-label="Image"> </div>
Definition	<p>a). Sufficient gap between system front-cover &amp; PCB assembly is a must for preventing from abnormal display after backpack test, hinge test, twist test or pogo test.</p> <p>b). Interference between panel and system front-cover is forbidden after reliability test.</p> <p>c). Interference is also forbidden in the act of system front-cover deformation during swing test, hinge test, knock test, or during pooling inspection procedure.</p> <p>d). To remain sufficient gap, design with system rib higher than maximum panel thickness is recommended.</p> <p>Note: Recommend for D1 at least 0.1mm gap, D2 at least 2.0mm gap. If the gap is less than recommendation, please check with INX.</p>
5	<p><b>Interference examination of antenna cable and WebCam wire</b></p> <div data-bbox="438 1202 1147 1691" data-label="Image"> </div>
Definition	<p>a). Antenna cable or WebCam wire overlap with panel outline is forbidden for preventing from abnormal display &amp; white spot after backpack test, hinge test, twist test or pogo test.</p> <p>b). Antenna cable or WebCam wire bypass panel outline is recommended.</p> <p>c). Interference between panel and system rear-cover is forbidden after reliability test.</p>
6	<p><b>System rear-cover inner surface examination</b></p>

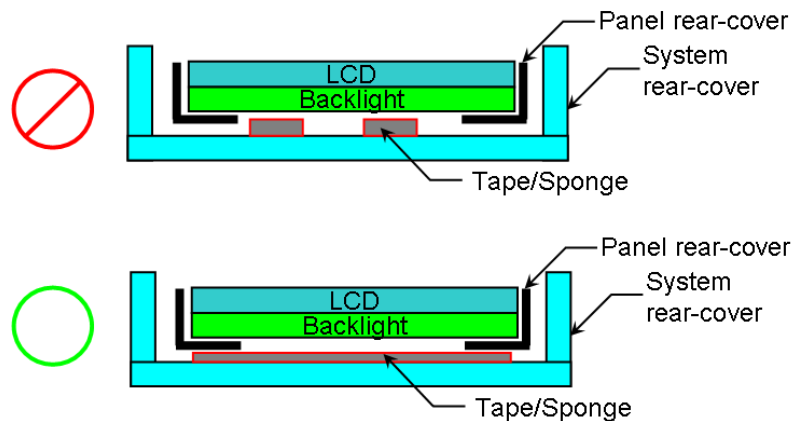


## PRODUCT SPECIFICATION



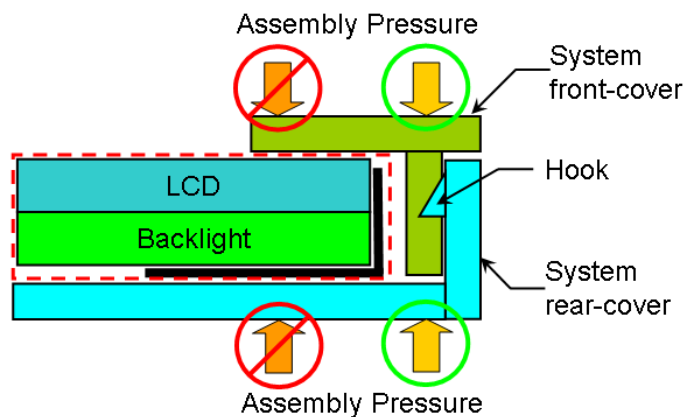
Definition	<p>a). Burr at logo edge, step, protrusion or PCB board will easily cause white spot or glass broken.</p> <p>b). Keeping flat surface underneath backlight is recommended.</p> <p>c). Interference between panel and system cover is forbidden after reliability test.</p>
------------	--

### 7 Tape/sponge design on system inner surface



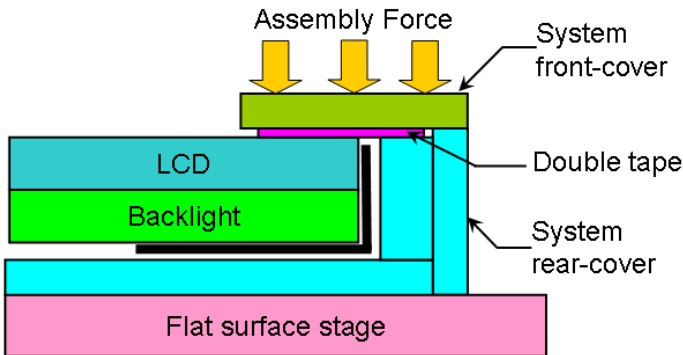
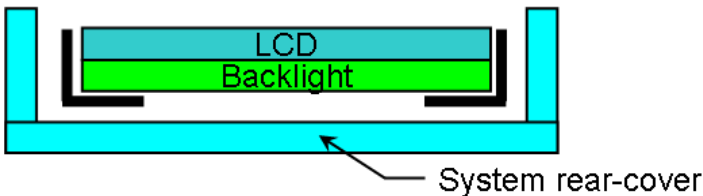
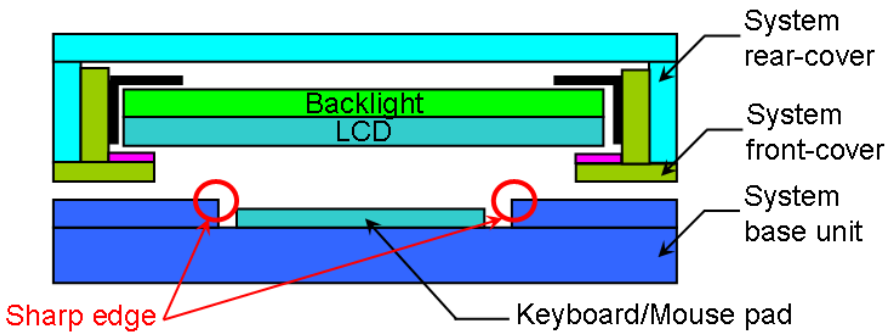
Definition	<p>a) To prevent abnormal display &amp; white spot after scuffing test, hinge test, pogo test, backpack test, it is not recommended to add tape/sponge in separate location. Since each tape/sponge may act as pressure concentration location.</p> <p>b) We suggest to design with a tape/sponge that well covered under panel rear-cover.</p> <p>c). Interference between panel and system rear-cover is forbidden after reliability test.</p>
------------	--

### 8 Assembly SOP examination

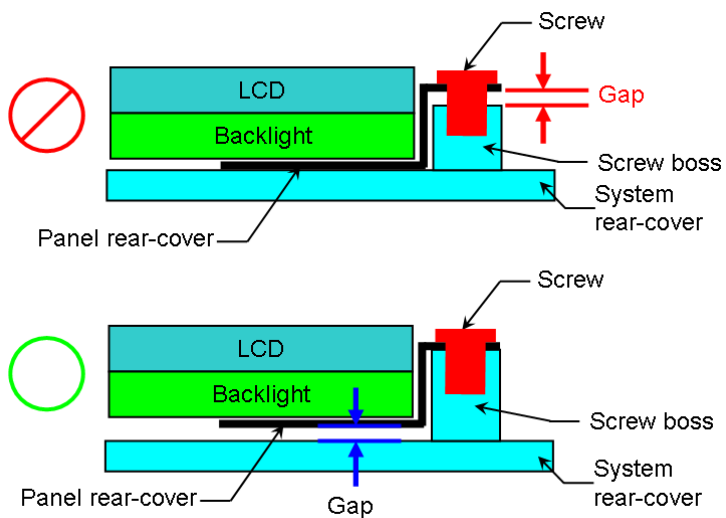


Definition	To prevent panel crack during system front-cover assembly process with hook design, it is prohibited to press panel or any location that related directly to the panel.
------------	---

# PRODUCT SPECIFICATION

9	<b>Assembly SOP examination</b>
	
Definition	To prevent panel crack during system front-cover assembly process without hook design, it is only allowed to give slight pressure with large contact area. This can help to distribute the stress and prevent stress concentration. Also it is suggest to put the system on a flat surface stage during the assembly.
10	<b>Material used for system rear-cover</b>
	
Definition	<p>a) To prevent abnormal display &amp; white spot after scuffing test, hinge test, pogo test, backpack test, as the poor rigidity result from deformation of system rear-cover during the test.</p> <p>b) We suggest using aluminum-magnesium alloy as the system rear-cover material with thickness min 1.5mm, instead of using PC/ABS.</p>
11	<b>System base unit design near keyboard and mouse pad</b>
	
Definition	To prevent abnormal display & white spot after scuffing test, hinge test, pogo test, backpack test, no sharp edge design is allowed in any area that may damage the panel during the test. We suggest to remove all sharp edges, or to reduce the thickness difference of keyboard/mouse pad from the nearby surface.
12	<b>Screw boss height design</b>

## PRODUCT SPECIFICATION

	
Definition	<p>a). Gap left between panel rear-cover bracket and screw boss surface is prohibited.</p> <p>b). To remain sufficient gap between panel and system rear-cover, screw boss height must be designed with respect to the height of bracket bottom surface to panel bottom surface + flatness change of panel itself.</p>

# PRODUCT SPECIFICATION

**Doc. Number:**

- ☐ Tentative Specification  
☐ Preliminary Specification  
☒ Approval Specification

**MODEL NO.: N140BGE**  
**SUFFIX: L32**

**Customer: for common model**

**APPROVED BY**

**SIGNATURE**

**Name / Title**

Please return 1 copy for your confirmation with your signature and comments.

Approved By	Checked By	Prepared By
楊竣傑	曹文彬	郭凡好
2013-03-22 08:50:46 CST	2013-03-21 14:00:32 CST	2013-03-15 13:01:31 CST

# PRODUCT SPECIFICATION

## CONTENTS

<b>1. GENERAL DESCRIPTION .....</b>	<b>4</b>
1.1 OVERVIEW .....	4
1.2 GENERAL SPECIFICATIONS .....	4
<b>2. MECHANICAL SPECIFICATIONS .....</b>	<b>4</b>
2.1 CONNECTOR TYPE .....	4
<b>3. ABSOLUTE MAXIMUM RATINGS .....</b>	<b>5</b>
3.1 ABSOLUTE RATINGS OF ENVIRONMENT .....	5
3.2 ELECTRICAL ABSOLUTE RATINGS .....	5
3.2.1 TFT LCD MODULE .....	5
<b>4. ELECTRICAL SPECIFICATIONS .....</b>	<b>6</b>
4.1 FUNCTION BLOCK DIAGRAM .....	6
4.2. INTERFACE CONNECTIONS .....	6
4.3 ELECTRICAL CHARACTERISTICS .....	8
4.3.1 LCD ELETRONICS SPECIFICATION .....	8
4.3.2 LED CONVERTER SPECIFICATION .....	10
4.3.3 BACKLIGHT UNIT .....	12
4.4 LVDS INPUT SIGNAL TIMING SPECIFICATIONS .....	13
4.4.1 LVDS DC SPECIFICATIONS .....	13
4.4.2 LVDS DATA FORMAT .....	13
4.4.3 COLOR DATA INPUT ASSIGNMENT .....	14
4.5 DISPLAY TIMING SPECIFICATIONS .....	15
4.6 POWER ON/OFF SEQUENCE .....	16
<b>5. OPTICAL CHARACTERISTICS .....</b>	<b>17</b>
5.1 TEST CONDITIONS .....	17
5.2 OPTICAL SPECIFICATIONS .....	17
<b>6. RELIABILITY TEST ITEM .....</b>	<b>20</b>
<b>7. PACKING .....</b>	<b>21</b>
7.1 MODULE LABEL .....	21
7.2 CARTON .....	22
7.3 PALLET .....	23
<b>8. PRECAUTIONS .....</b>	<b>24</b>
8.1 HANDLING PRECAUTIONS .....	24
8.2 STORAGE PRECAUTIONS .....	24
8.3 OPERATION PRECAUTIONS .....	24
Appendix. EDID DATA STRUCTURE .....	25
Appendix. OUTLINE DRAWING .....	28
Appendix. SYSTEM COVER DESIGN GUIDANCE .....	30

# PRODUCT SPECIFICATION

## REVISION HISTORY

Version	Date	Page	Description
3.0	Dec 14, 2011	All	Approval Spec Ver.3.0 was first issued.
3.1	Mar. 02,2013	21,30	Update Spec LOGO, Module Label, Design Guidance

## 1. GENERAL DESCRIPTION

### 1.1 OVERVIEW

N140BGE-L32 is a 14.0" (14.0" diagonal) TFT Liquid Crystal Display module with LED Backlight unit and 40 pins LVDS interface. This module supports 1366 x 768 HD mode and can display 262,144 colors.

The optimum viewing angle is at 6 o'clock direction.

### 1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	14.0" diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1366 x R.G.B. x 768	pixel	-
Pixel Pitch	0.2265 (H) x 0.2265 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	262,144	color	-
Transmissive Mode	Normally white	-	-
Surface Treatment	Hard coating (3H), Anti-Glare	-	-
Luminance, White	200	Cd/m2	
Power Consumption	Total 3.34W (Max.) @ cell ,0.7 W (Max.), BL 2.64 W (Max.)		(1)

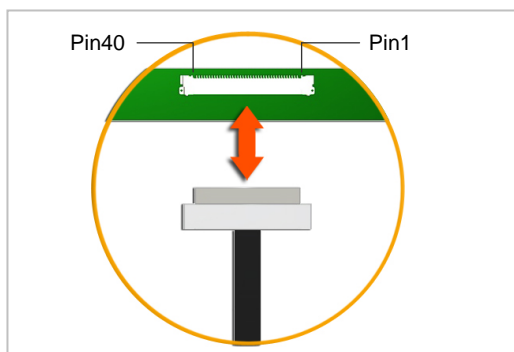
Note (1) The specified power consumption (with converter efficiency) is under the conditions at VCCS = 3.3 V,  $f_v = 60$  Hz, LED\_VCCS = Typ,  $f_{PWM} = 200$  Hz, Duty=100% and  $T_a = 25 \pm 2$  °C, whereas mosaic pattern is displayed.

## 2. MECHANICAL SPECIFICATIONS

Item	Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	319.9	320.4	320.9	mm
	Vertical (V)	204.6	205.1	205.6	mm
	Thickness (T)	-	-	3.6	mm
Active Area	Horizontal	309.099	309.399	309.699	mm
	Vertical	173.652	173.952	174.252	mm
Weight	-	310	320	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

### 2.1 CONNECTOR TYPE



Please refer Appendix Outline Drawing for detail design.

Connector Part No.: IPEX-20455-040E-12 & Foxconn-GS13401-1110A-7H or equivalent

User's connector Part No: IPEX-20453-040T-01 or equivalent

# PRODUCT SPECIFICATION

## 3. ABSOLUTE MAXIMUM RATINGS

### 3.1 ABSOLUTE RATINGS OF ENVIRONMENT

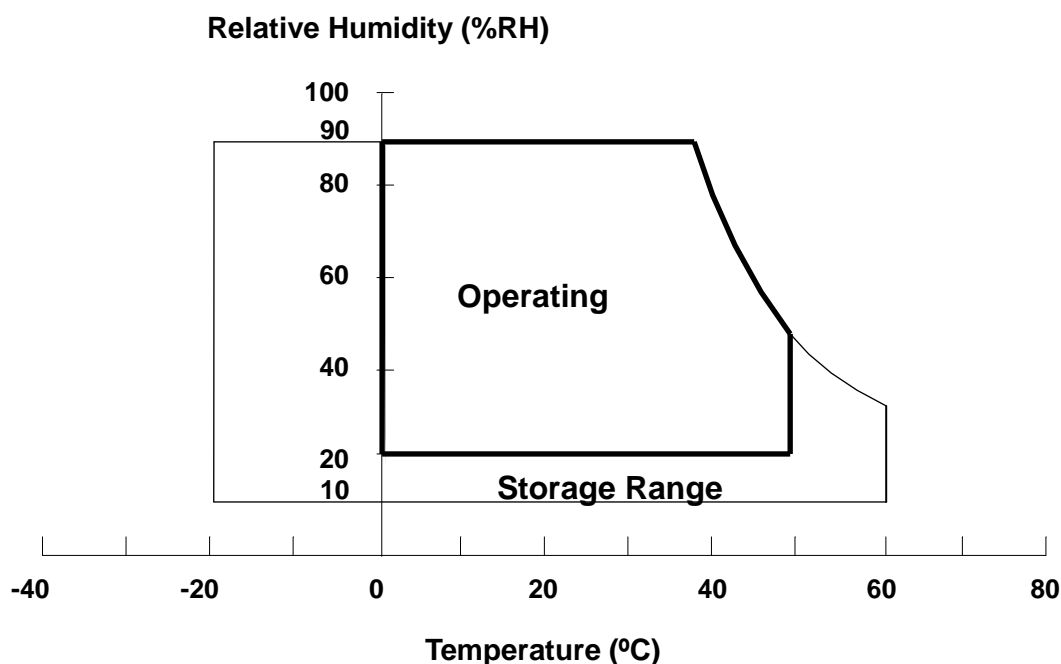
Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	T <sub>ST</sub>	-20	+60	°C	(1)
Operating Ambient Temperature	T <sub>OP</sub>	0	+50	°C	(1), (2)

Note (1) (a) 90 %RH Max. (Ta ≤ 40 °C).

(b) Wet-bulb temperature should be 39 °C Max. (Ta > 40 °C).

(c) No condensation.

Note (2) The temperature of panel surface should be 0 °C min. and 60 °C max.



## 3.2 ELECTRICAL ABSOLUTE RATINGS

### 3.2.1 TFT LCD MODULE

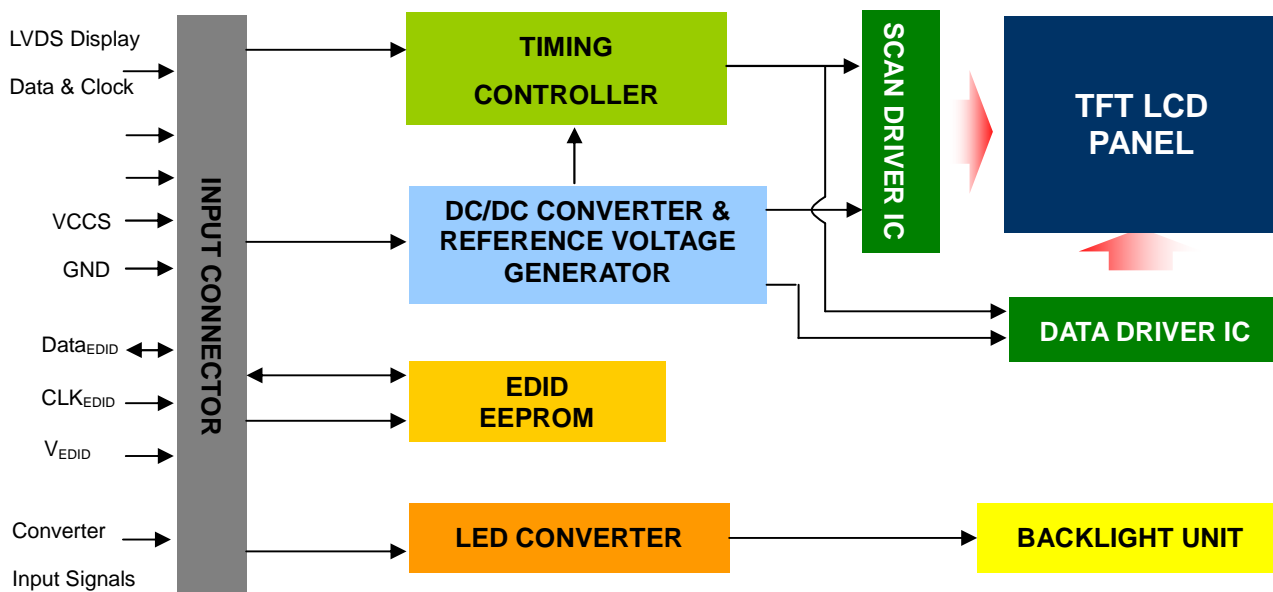
Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	VCCS	-0.3	+4.0	V	(1)
Logic Input Voltage	V <sub>IN</sub>	-0.3	VCCS+0.3	V	
Converter Input Voltage	LED_VCCS	-0.3	25.0	V	(1)
Converter Control Signal Voltage	LED_PWM,	-0.3	3.6	V	(1)
Converter Control Signal Voltage	LED_EN	-0.3	3.6	V	(1)

Note (1) Stresses beyond those listed in above “ELECTRICAL ABSOLUTE RATINGS” may cause permanent damage to the device. Normal operation should be restricted to the conditions described in “ELECTRICAL CHARACTERISTICS”.



## 4. ELECTRICAL SPECIFICATIONS

### 4.1 FUNCTION BLOCK DIAGRAM



### 4.2. INTERFACE CONNECTIONS

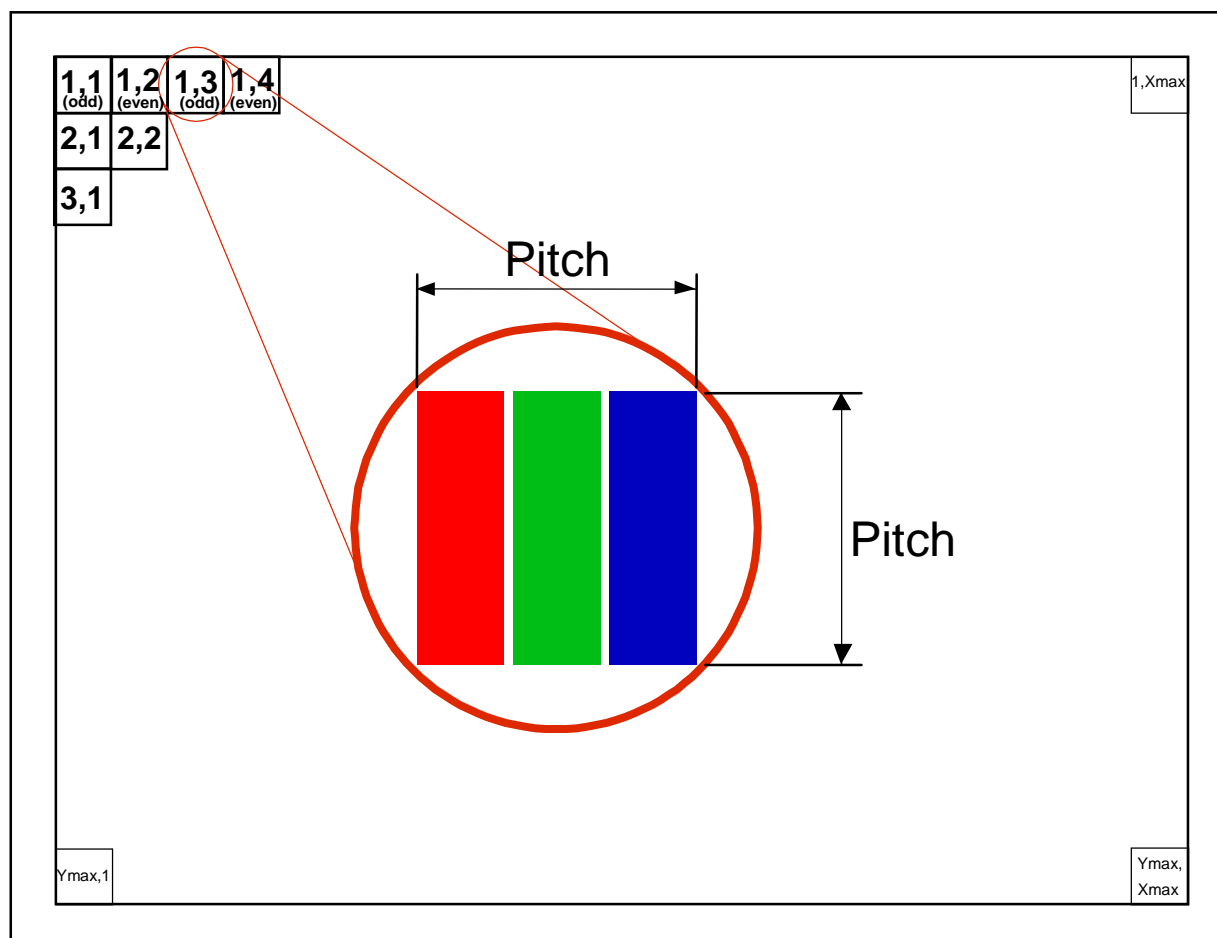
#### PIN ASSIGNMENT

Pin	Symbol	Description	Remark
1	NC	No Connection (Reserve)	
2	VCCS	Power Supply (3.3V typ.)	
3	VCCS	Power Supply (3.3V typ.)	
4	VEDID	DDC 3.3V power	
5	NC	No Connection (Reserved for INNOLUX test)	
6	CLKEDID	DDC clock	
7	DATAEDID	DDC data	
8	Rxin0-	LVDS differential data input	R0-R5, G0
9	Rxin0+	LVDS differential data input	
10	VSS	Ground	
11	Rxin1-	LVDS differential data input	G1~G5, B0, B1
12	Rxin1+	LVDS differential data input	
13	VSS	Ground	
14	Rxin2-	LVDS Differential Data Input	B2-B5,HS,VS, DE
15	Rxin2+	LVDS Differential Data Input	
16	VSS	Ground	
17	RxCLK-	LVDS differential clock input	LVDS CLK
18	RxCLK+	LVDS differential clock input	
19	VSS	Ground	
20	NC	No Connection (Reserve)	
21	NC	No Connection (Reserve)	
22	VSS	Ground	

## PRODUCT SPECIFICATION

23	NC	No Connection (Reserve)	
24	NC	No Connection (Reserve)	
25	VSS	Ground	
26	NC	No Connection (Reserve)	
27	NC	No Connection (Reserve)	
28	VSS	Ground	
29	NC	No Connection (Reserve)	
30	NC	No Connection (Reserve)	
31	LED_GND	LED Ground	
32	LED_GND	LED Ground	
33	LED_GND	LED Ground	
34	NC	No Connection (Reserve)	
35	LED_PWM	PWM Control Signal of LED Converter	
36	LED_EN	Enable Control Signal of LED Converter	
37	NC	No Connection (Reserve)	
38	LED_VCCS	LED Power Supply	
39	LED_VCCS	LED Power Supply	
40	LED_VCCS	LED Power Supply	

Note (1) The first pixel is odd as shown in the following figure.



# PRODUCT SPECIFICATION

## 4.3 ELECTRICAL CHARACTERISTICS

### 4.3.1 LCD ELETRONICS SPECIFICATION

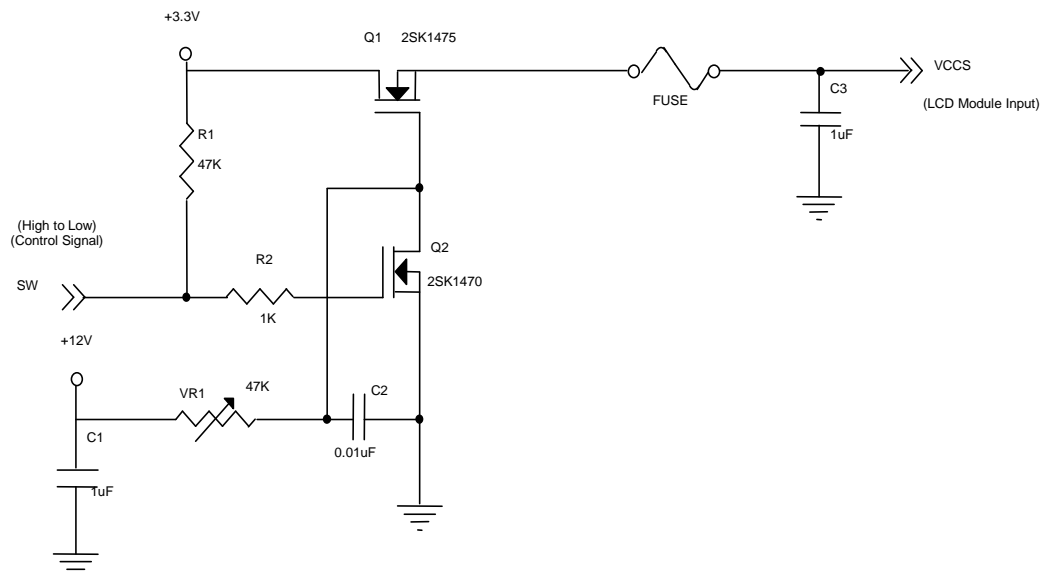
Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Power Supply Voltage	VCCS	3.0	3.3	3.6	V	(1)
Ripple Voltage	V <sub>RP</sub>	-	50	-	mV	(1)
Inrush Current	I <sub>RUSH</sub>	-	-	1.5	A	(1),(2)
Power Supply Current	Mosaic	130	145	160	mA	(3)a
	Black	120	135	150	mA	(3)b

Note (1) The ambient temperature is  $T_a = 25 \pm 2^\circ\text{C}$ .

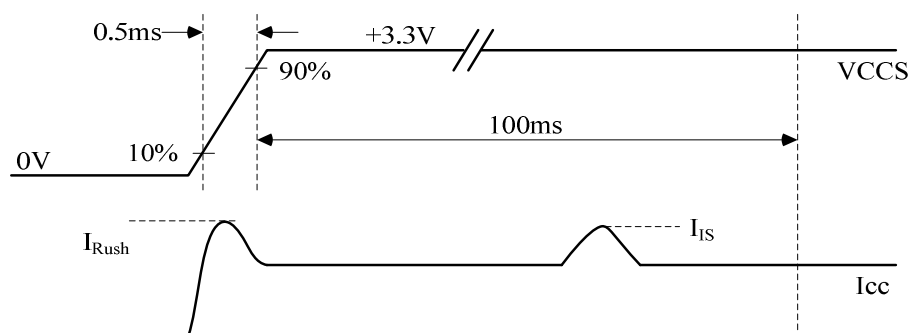
Note (2) I<sub>RUSH</sub>: the maximum current when VCCS is rising

I<sub>IS</sub>: the maximum current of the first 100ms after power-on

Measurement Conditions: Shown as the following figure. Test pattern: black.



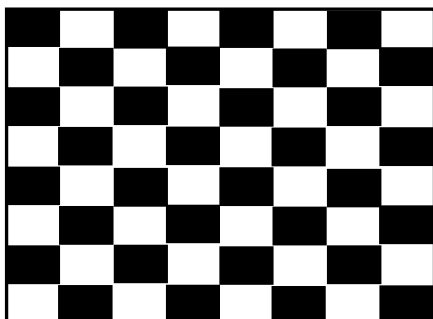
**VCCS rising time is 0.5ms**



## PRODUCT SPECIFICATION

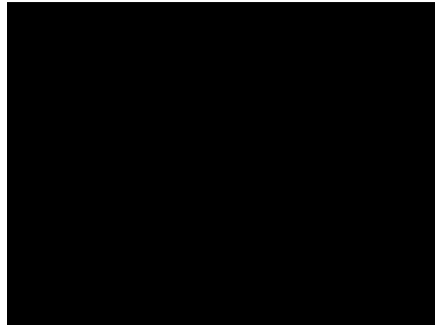
Note (3) The specified power supply current is under the conditions at  $V_{CCS} = 3.3\text{ V}$ ,  $T_a = 25 \pm 2\text{ }^{\circ}\text{C}$ , DC Current and  $f_v = 60\text{ Hz}$ , whereas a power dissipation check pattern below is displayed.

a. Mosaic Pattern



Active Area

b. Black Pattern



Active Area

# PRODUCT SPECIFICATION

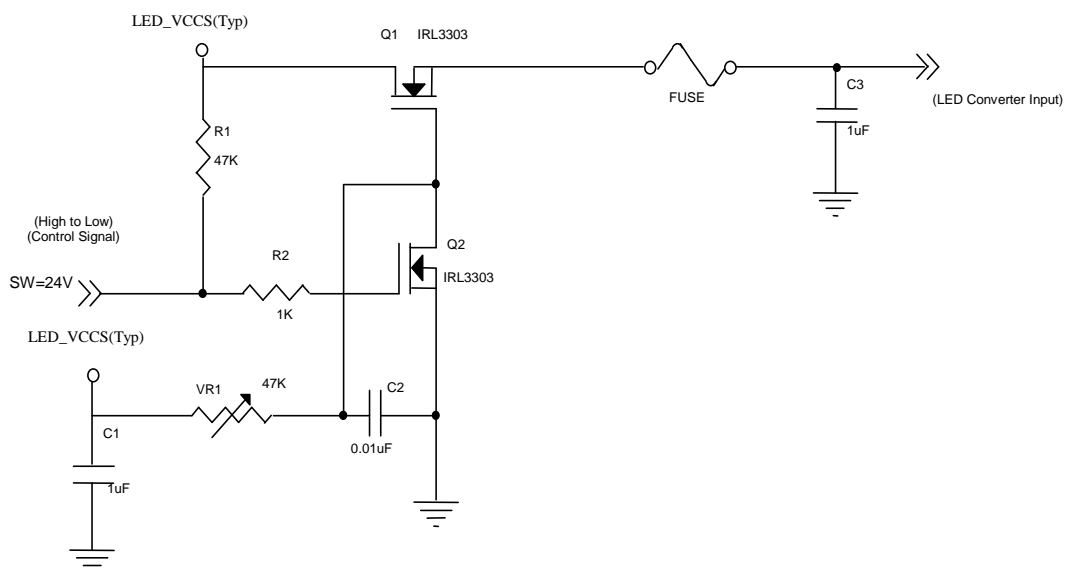
## 4.3.2 LED CONVERTER SPECIFICATION

Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Converter Input power supply voltage		LED_Vccs	6.0	12.0	21.0	V	
Converter Inrush Current		I <sub>LED_RUSH</sub>	-	-	1.5	A	(1)
EN Control Level	Backlight On		2.3	-	3.6	V	
	Backlight Off		0	-	0.5	V	
PWM Control Level	PWM High Level		2.3	-	3.6	V	
	PWM Low Level		0	-	0.5	V	
PWM Control Duty Ratio			10	-	100	%	
			5	-	100	%	(2)
PWM Control Permissive Ripple Voltage		V <sub>PWM_pp</sub>	-	-	100	mV	
PWM Control Frequency		f <sub>PWM</sub>	190	-	2K	Hz	(3)
LED Power Current	LED_VCCS =Typ.	I <sub>LED</sub>	163	200	220	mA	(4)

Note (1) I<sub>LED\_RUSH</sub>: the maximum current when LED\_VCCS is rising,

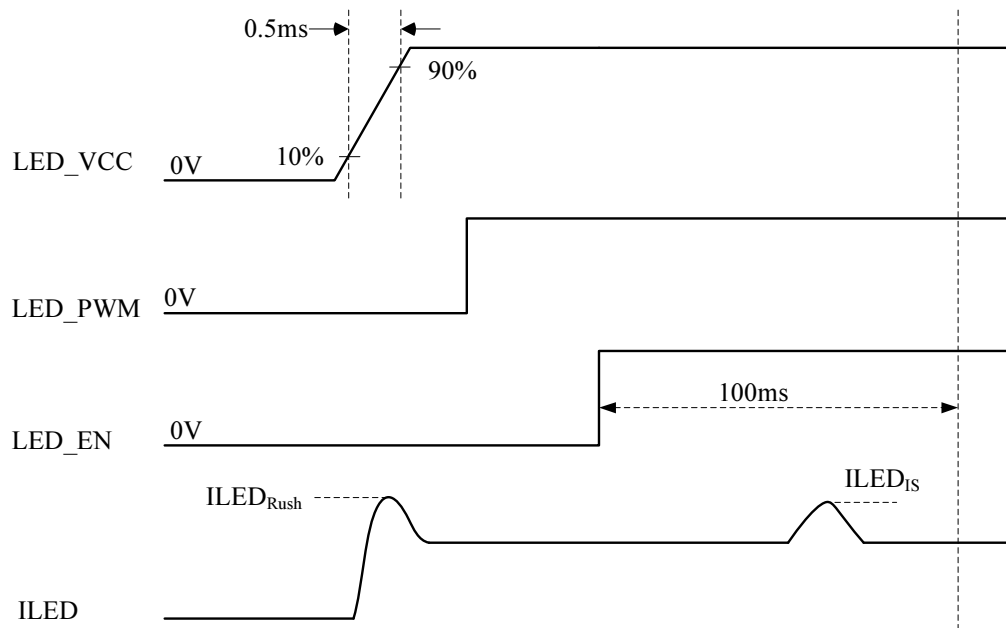
I<sub>LED\_IS</sub>: the maximum current of the first 100ms after power-on,

Measurement Conditions: Shown as the following figure. LED\_VCCS = Typ, Ta = 25 ± 2 °C, f<sub>PWM</sub> = 200 Hz, Duty=100%.



# PRODUCT SPECIFICATION

## VLED rising time is 0.5ms



Note (2) If the PWM control duty ratio is less than 10%, there is some possibility that acoustic noise or backlight flash can be found. And it is also difficult to control the brightness linearity.

Note (3) If PWM control frequency is applied in the range less than 1KHz, the “waterfall” phenomenon on the screen may be found. To avoid the issue, it's a suggestion that PWM control frequency should follow the criterion as below.

PWM control frequency  $f_{PWM}$  should be in the range

$$(N + 0.33) * f \leq f_{PWM} \leq (N + 0.66) * f$$

$N$  : Integer ( $N \geq 3$ )

$f$  : Frame rate

Note (4) The specified LED power supply current is under the conditions at “LED\_VCCS = Typ.”,  $T_a = 25 \pm 2^\circ\text{C}$ ,  $f_{PWM} = 200\text{ Hz}$ , Duty=100%.

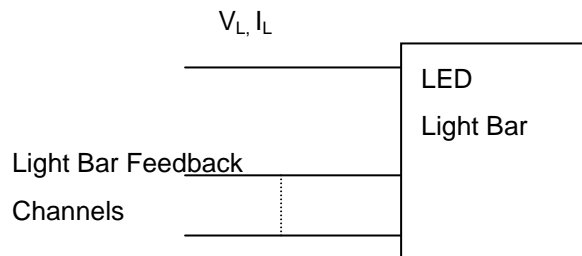
# PRODUCT SPECIFICATION

## 4.3.3 BACKLIGHT UNIT

Ta = 25 ± 2 °C

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
LED Light Bar Power Supply Voltage	V <sub>L</sub>	27.5	30.8	33	V	(1)(2)(Duty100%)
LED Light Bar Power Supply Current	I <sub>L</sub>	62.7	66	69.3	mA	
Power Consumption	P <sub>L</sub>	1.72	2.03	2.28	W	(3)
LED Life Time	L <sub>BL</sub>	15000	-	-	Hrs	(4)

Note (1) LED current is measured by utilizing a high frequency current meter as shown below :



Note (2) For better LED light bar driving quality, it is recommended to utilize the adaptive boost converter with current balancing function to drive LED light-bar.

Note (3)  $P_L = I_L \times V_L$  (Without LED converter transfer efficiency)

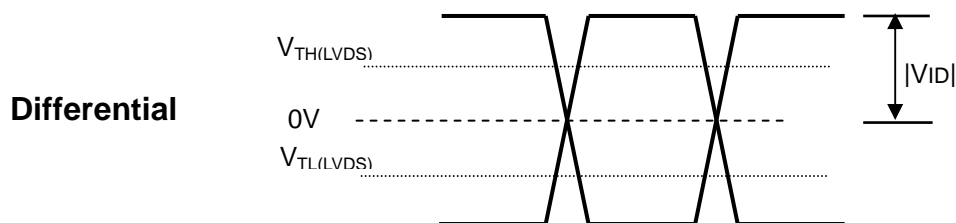
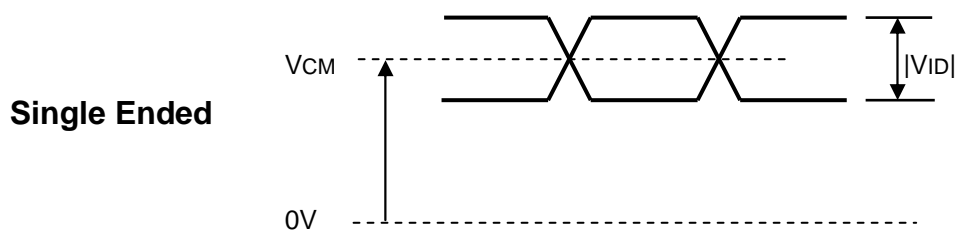
Note (4) The lifetime of LED is defined as the time when it continues to operate under the conditions at Ta = 25 ± 2 °C and I<sub>L</sub> = 22 mA(Per EA) until the brightness becomes ≤ 50% of its original value.

## 4.4 LVDS INPUT SIGNAL TIMING SPECIFICATIONS

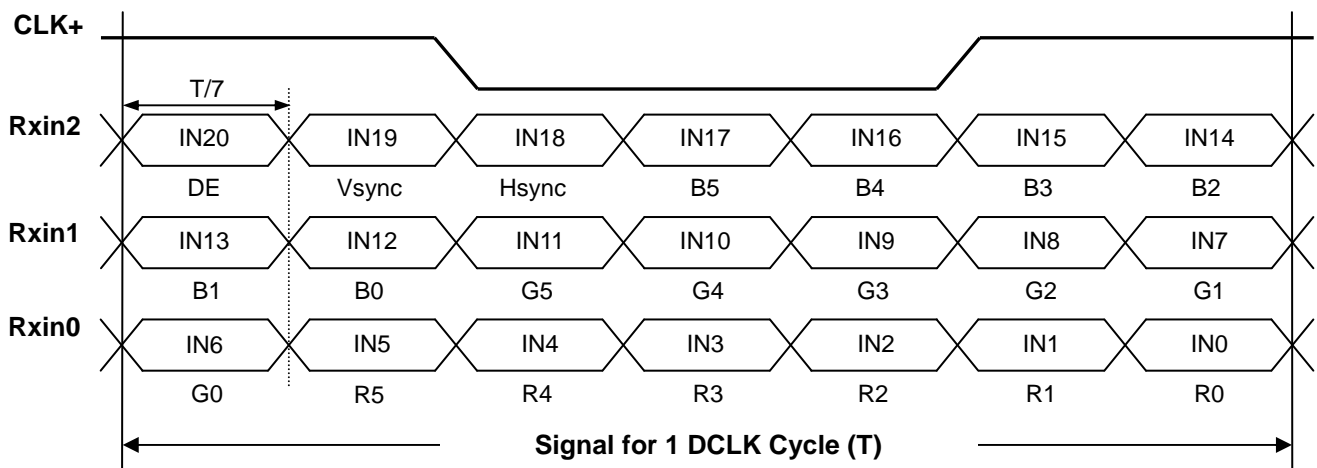
### 4.4.1 LVDS DC SPECIFICATIONS

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
LVDS Differential Input High Threshold	$V_{TH(LVDS)}$	-	-	+100	mV	(1), $V_{CM}=1.2V$
LVDS Differential Input Low Threshold	$V_{TL(LVDS)}$	-100	-	-	mV	(1), $V_{CM}=1.2V$
LVDS Common Mode Voltage	$V_{CM}$	1.125	-	1.375	V	(1)
LVDS Differential Input Voltage	$ V_{ID} $	100	-	600	mV	(1)
LVDS Terminating Resistor	$R_T$		100		Ohm	-

Note (1) The parameters of LVDS signals are defined as the following figures.



### 4.4.2 LVDS DATA FORMAT





# PRODUCT SPECIFICATION

## 4.4.3 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

Color		Data Signal																	
		Red						Green						Blue					
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
Gray Scale Of Green	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(61)	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
	Green(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0	
Gray Scale Of Blue	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	

Note (1) 0: Low Level Voltage, 1: High Level Voltage

# PRODUCT SPECIFICATION

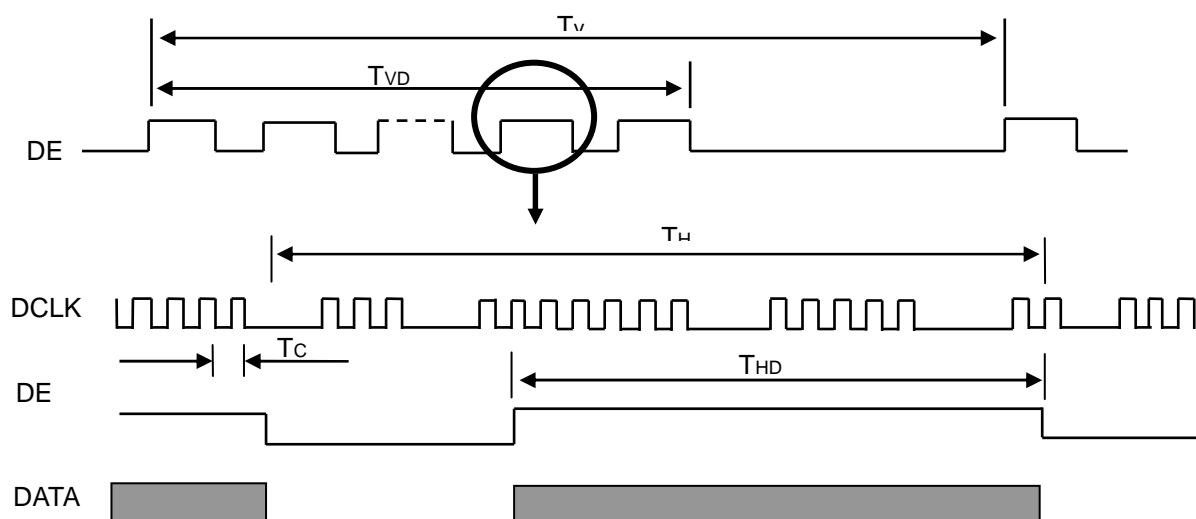
## 4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
DCLK	Frequency	1/Tc	45	69.3	77	MHz	-
DE	Vertical Total Time	TV	780	788	798	TH	-
	Vertical Active Display Period	TVD	768	768	768	TH	-
	Vertical Active Blanking Period	TVB	TV-TVD	20	TV-TVD	TH	-
	Horizontal Total Time	TH	1456	1466	1476	Tc	-
	Horizontal Active Display Period	THD	1366	1366	1366	Tc	-
	Horizontal Active Blanking Period	THB	TH-THD	100	TH-THD	Tc	-

Note (1) Because this module is operated by DE only mode, Hsync and Vsync are ignored.

### INPUT SIGNAL TIMING DIAGRAM

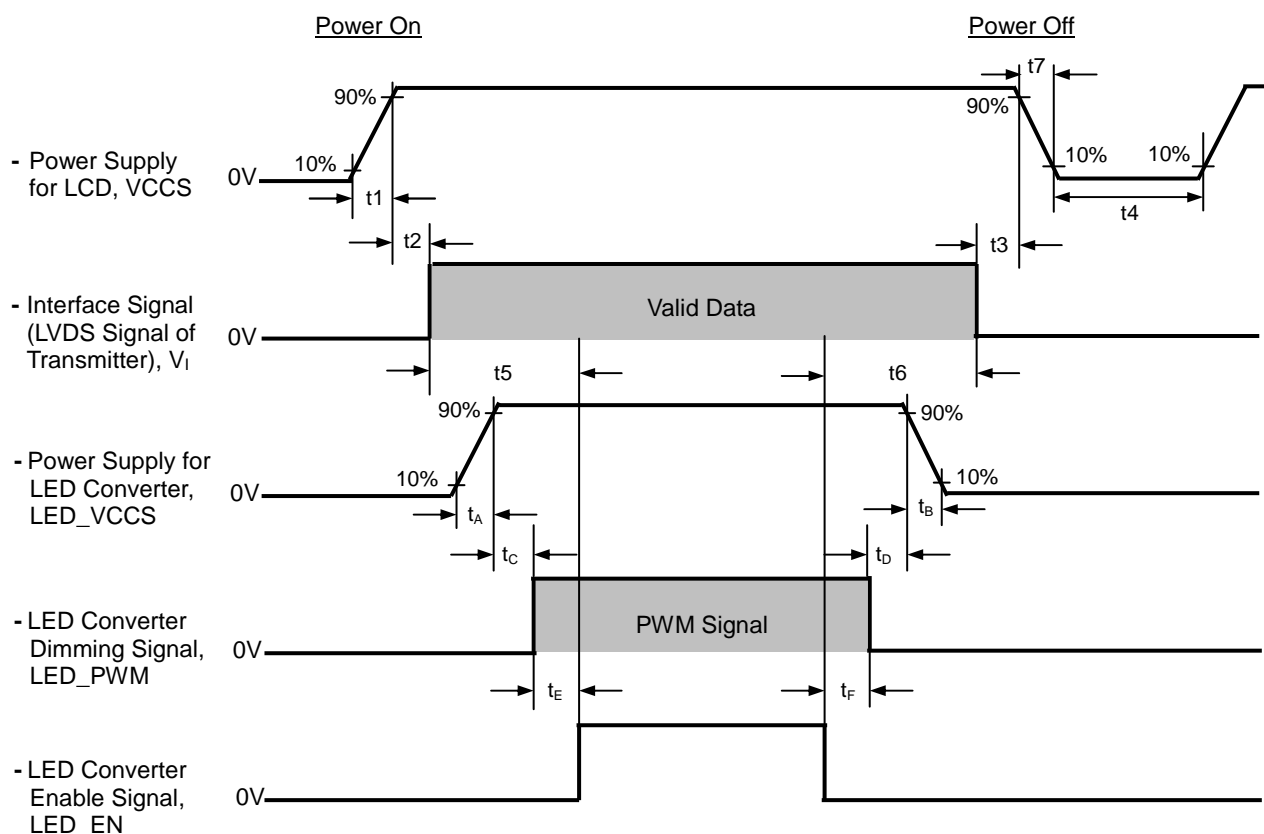


# PRODUCT SPECIFICATION

## 4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.

Symbol	Value			Unit	Note
	Min.	Typ.	Max.		
t1	0.5	-	10	ms	
t2	0	-	50	ms	
t3	0	-	50	ms	
t4	500	-	-	ms	
t5	200	-	-	ms	
t6	200	-	-	ms	
t7	0.5	-	10	ms	
t <sub>A</sub>	0.5	-	10	ms	
t <sub>B</sub>	0	-	10	ms	
t <sub>C</sub>	10	-	-	ms	
t <sub>D</sub>	10	-	-	ms	
t <sub>E</sub>	10	-	-	ms	
t <sub>F</sub>	10	-	-	ms	



Note (1) Please don't plug or unplug the interface cable when system is turned on.

Note (2) Please avoid floating state of the interface signal during signal invalid period.

Note (3) It is recommended that the backlight power must be turned on after the power supply for LCD and the interface signal is valid.

# PRODUCT SPECIFICATION

## 5. OPTICAL CHARACTERISTICS

### 5.1 TEST CONDITIONS

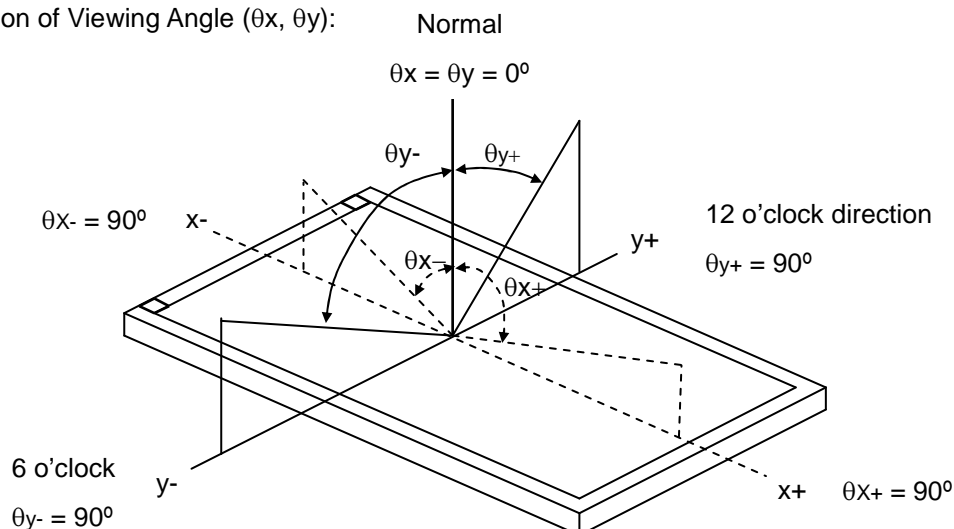
Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	Ha	50±10	%RH
Supply Voltage	V <sub>CC</sub>	3.3	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Light Bar Input Current	I <sub>L</sub>	66	mA

The measurement methods of optical characteristics are shown in Section 5.2. The following items should be measured under the test conditions described in Section 5.1 and stable environment shown in Note (5).

### 5.2 OPTICAL SPECIFICATIONS

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Contrast Ratio		CR	$\theta_x=0^\circ, \theta_Y=0^\circ$ Viewing Normal Angle	300	500	-	-	(2), (5) (7)
Response Time		T <sub>R</sub>		-	4	8	ms	(3),(7)
		T <sub>F</sub>		-	6	12	ms	
Average Luminance of White		L <sub>Ave</sub>		170	200	-	cd/m <sup>2</sup>	(4), (6),(7)
Color Chromaticity	Red	R <sub>x</sub>		Typ – 0.03	0.590	Typ + 0.03	-	(1),(7)
		R <sub>y</sub>			0.342		-	
	Green	G <sub>x</sub>			0.330		-	
		G <sub>y</sub>			0.562		-	
	Blue	B <sub>x</sub>			0.160		-	
		B <sub>y</sub>			0.140		-	
	White	W <sub>x</sub>			0.313		-	
		W <sub>y</sub>			0.329		-	
Viewing Angle	Horizontal	θ <sub>x</sub> +	40	45	-	Deg.	(1),(5), (7)	
		θ <sub>x</sub> -	40	45				
	Vertical	θ <sub>y</sub> +	15	20				
		θ <sub>y</sub> -	40	45				
White Variation of 5 Points		δW <sub>5p</sub>	$\theta_x=0^\circ, \theta_Y=0^\circ$	80	-	-	%	(5),(6), (7)

Note (1) Definition of Viewing Angle ( $\theta_x, \theta_y$ ):



# PRODUCT SPECIFICATION

Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

$$\text{Contrast Ratio (CR)} = L_{63} / L_0$$

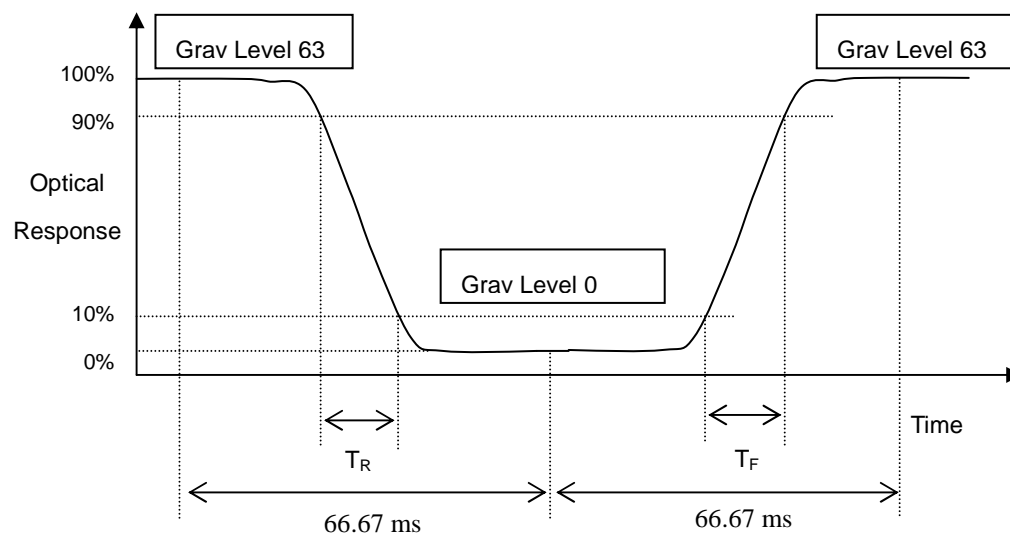
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

$$CR = CR (1)$$

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time ( $T_R$ ,  $T_F$ ):



Note (4) Definition of Average Luminance of White ( $L_{AVE}$ ):

Measure the luminance of White at 5 points

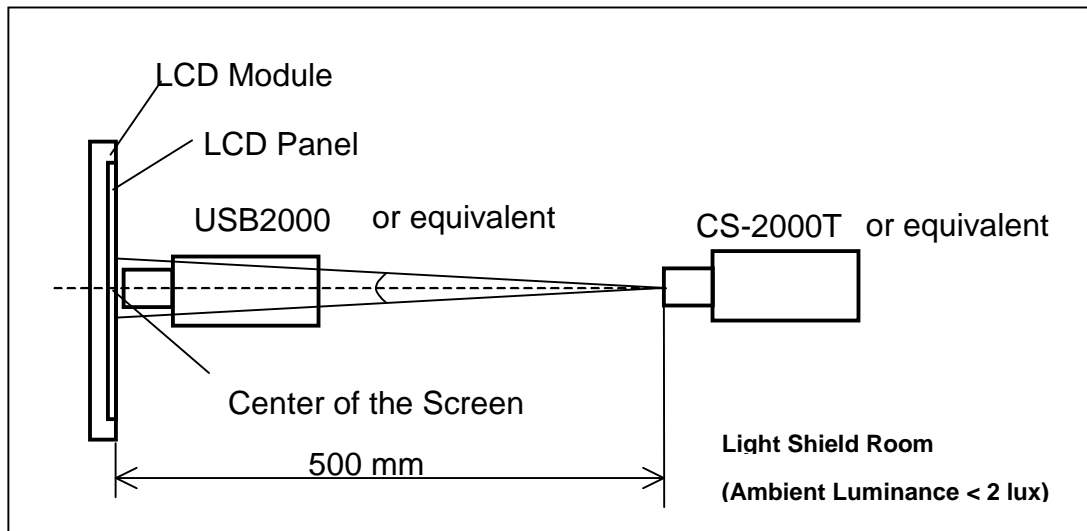
$$L_{AVE} = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5$$

L (x) is corresponding to the luminance of the point X at Figure in Note (6)

# PRODUCT SPECIFICATION

## Note (5) Measurement Setup:

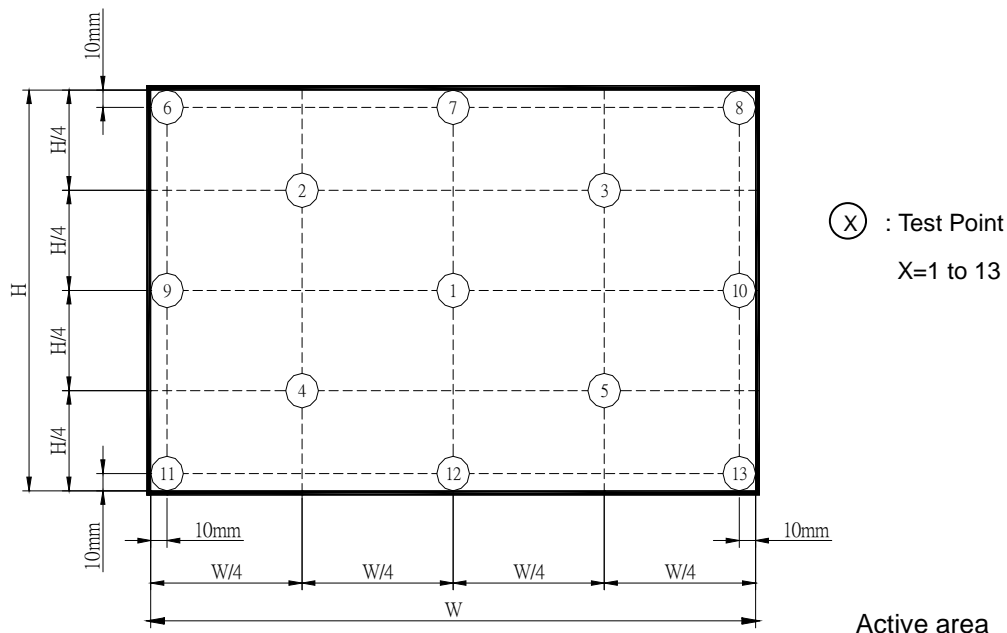
The LCD module should be stabilized at given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



## Note (6) Definition of White Variation ( $\delta W$ ):

Measure the luminance of White at 5 points

$$\delta W_{5p} = \{ \text{Minimum} [L(1) \sim L(5)] / \text{Maximum} [L(1) \sim L(5)] \} * 100\%$$



Note (7) The listed optical specifications refer to the initial value of manufacture, but the condition of the specifications after long-term operation will not be warranted.

## PRODUCT SPECIFICATION

### 6. RELIABILITY TEST ITEM

Test Item	Test Condition	Note
High Temperature Storage Test	60°C, 240 hours	(1) (2)
Low Temperature Storage Test	-20°C, 240 hours	
Thermal Shock Storage Test	-20°C, 0.5hour $\longleftrightarrow$ 60°C, 0.5hour; 100cycles, 1hour/cycle	
High Temperature Operation Test	50°C, 240 hours	
Low Temperature Operation Test	0°C, 240 hours	
High Temperature & High Humidity Operation Test	50°C, 80% RH, 240 hours	
ESD Test (Operation)	150pF, 330 $\Omega$ , 1sec/cycle Condition 1 : Contact Discharge, $\pm$ 8KV Condition 2 : Air Discharge, $\pm$ 15KV	(1)
Shock (Non-Operating)	220G, 2ms, half sine wave, 1 time for each direction of $\pm$ X, $\pm$ Y, $\pm$ Z	(1)(3)
Vibration (Non-Operating)	1.5G / 10-500 Hz, Sine wave, 30 min/cycle, 1cycle for each X, Y, Z	(1)(3)

Note (1) criteria : Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

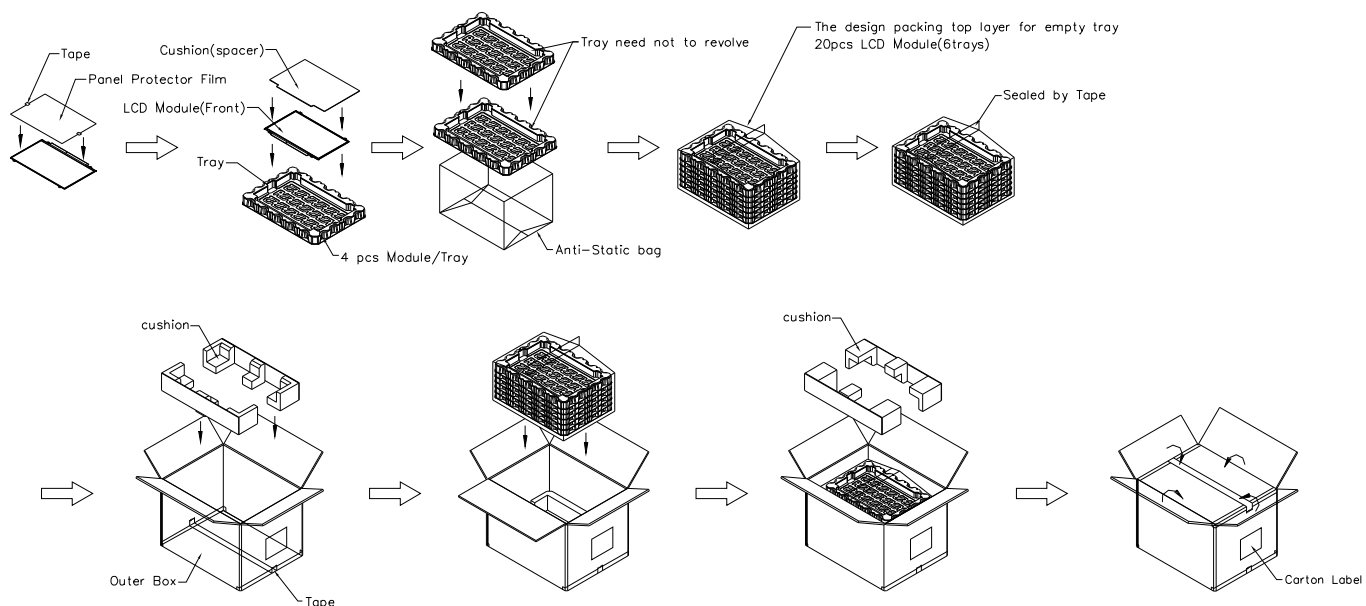
Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.





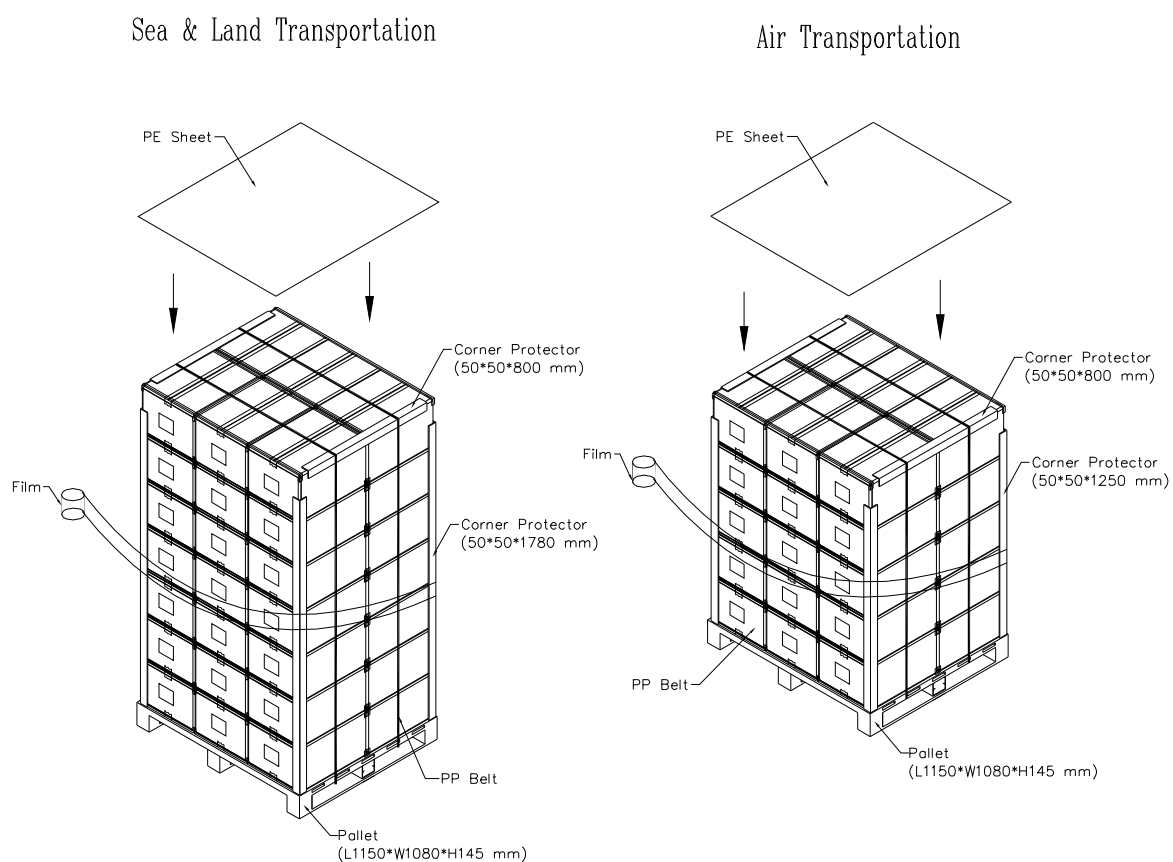
## 7.2 CARTON

Box Dimensions : 435(L)\*350(W)\*275(H)  
Weight : Approx. 8.09Kg (20 module .per. 1box)



**Figure. 7-2 Packing method**

## 7.3 PALLET



**Figure. 7-3 Packing method**

## 8. PRECAUTIONS

### 8.1 HANDLING PRECAUTIONS

- (1) The module should be assembled into the system firmly by using every mounting hole. Be careful not to twist or bend the module.
- (2) While assembling or installing modules, it can only be in the clean area. The dust and oil may cause electrical short or damage the polarizer.
- (3) Use fingerstalls or soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (4) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.
- (5) If the surface of the polarizer is dirty, please clean it by some absorbent cotton or soft cloth. Do not use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanently damage the polarizer due to chemical reaction.
- (6) Wipe off water droplets or oil immediately. Staining and discoloration may occur if they left on panel for a long time.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contacting with hands, legs or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static electricity, it may cause damage to the C-MOS Gate Array IC.
- (9) Do not disassemble the module.
- (10) Do not pull or fold the LED wire.
- (11) Pins of I/F connector should not be touched directly with bare hands.

### 8.2 STORAGE PRECAUTIONS

- (1) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (2) It is dangerous that moisture come into or contacted the LCD module, because the moisture may damage LCD module when it is operating.
- (3) It may reduce the display quality if the ambient temperature is lower than 10 °C. For example, the response time will become slowly, and the starting voltage of LED will be higher than the room temperature.

### 8.3 OPERATION PRECAUTIONS

- (1) Do not pull the I/F connector in or out while the module is operating.
- (2) Always follow the correct power on/off sequence when LCD module is connecting and operating. This can prevent the INXS LSI chips from damage during latch-up.
- (3) The startup voltage of Backlight is approximately 1000 Volts. It may cause electrical shock while assembling with converter. Do not disassemble the module or insert anything into the Backlight unit.

# PRODUCT SPECIFICATION

## Appendix. EDID DATA STRUCTURE

The EDID (Extended Display Identification Data) data formats are to support displays as defined in the VESA Plug & Display and FPD standards.

Byte # (decimal)	Byte # (hex)	Field Name and Comments	Value (hex)	Value (binary)
0	0	Header	00	00000000
1	1	Header	FF	11111111
2	2	Header	FF	11111111
3	3	Header	FF	11111111
4	4	Header	FF	11111111
5	5	Header	FF	11111111
6	6	Header	FF	11111111
7	7	Header	00	00000000
8	8	EISA ID manufacturer name ("CMN")	0D	00001101
9	9	EISA ID manufacturer name (Compressed ASCII)	AE	10101110
10	0A	ID product code (N140BGE-L32)	71	01110001
11	0B	ID product code (hex LSB first; N140BGE-L32)	14	00010100
12	0C	ID S/N (fixed "0")	00	00000000
13	0D	ID S/N (fixed "0")	00	00000000
14	0E	ID S/N (fixed "0")	00	00000000
15	0F	ID S/N (fixed "0")	00	00000000
16	10	Week of manufacture (fixed "00H")	23	00100011
17	11	Year of manufacture (fixed "00H")	15	00010101
18	12	EDID structure version # ("1")	01	00000001
19	13	EDID revision # ("3")	03	00000011
20	14	Video I/P definition ("digital")	80	10000000
21	15	Max H image size ("30.9cm")	1F	00011111
22	16	Max V image size ("17.4cm")	11	00010001
23	17	Display Gamma (Gamma = "2.2")	78	01111000
24	18	Feature support ("Active off, RGB Color")	0A	00001010
25	19	Red/Green (Rx1, Rx0, Ry1, Ry0, Gx1, Gx0, Gy1, Gy0)	D1	11010001
26	1A	Blue/White (Bx1, Bx0, By1, By0, Wx1, Wx0, Wy1, Wy0)	45	01000101
27	1B	Red-x (Rx = "0.608")	9B	10011011
28	1C	Red-y (Ry = "0.349")	59	01011001
29	1D	Green-x (Gx = "0.340")	57	01010111
30	1E	Green-y (Gy = "0.556")	8E	10001110
31	1F	Blue-x (Bx = "0.169")	2B	00101011
32	20	Blue-y (By = "0.137")	23	00100011
33	21	White-x (Wx = "0.313")	50	01010000
34	22	White-y (Wy = "0.329")	54	01010100
35	23	Established timings 1	00	00000000
36	24	Established timings 2	00	00000000
37	25	Manufacturer's reserved timings	00	00000000
38	26	Standard timing ID # 1	01	00000001
39	27	Standard timing ID # 1	01	00000001
40	28	Standard timing ID # 2	01	00000001

# PRODUCT SPECIFICATION

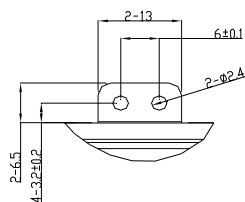
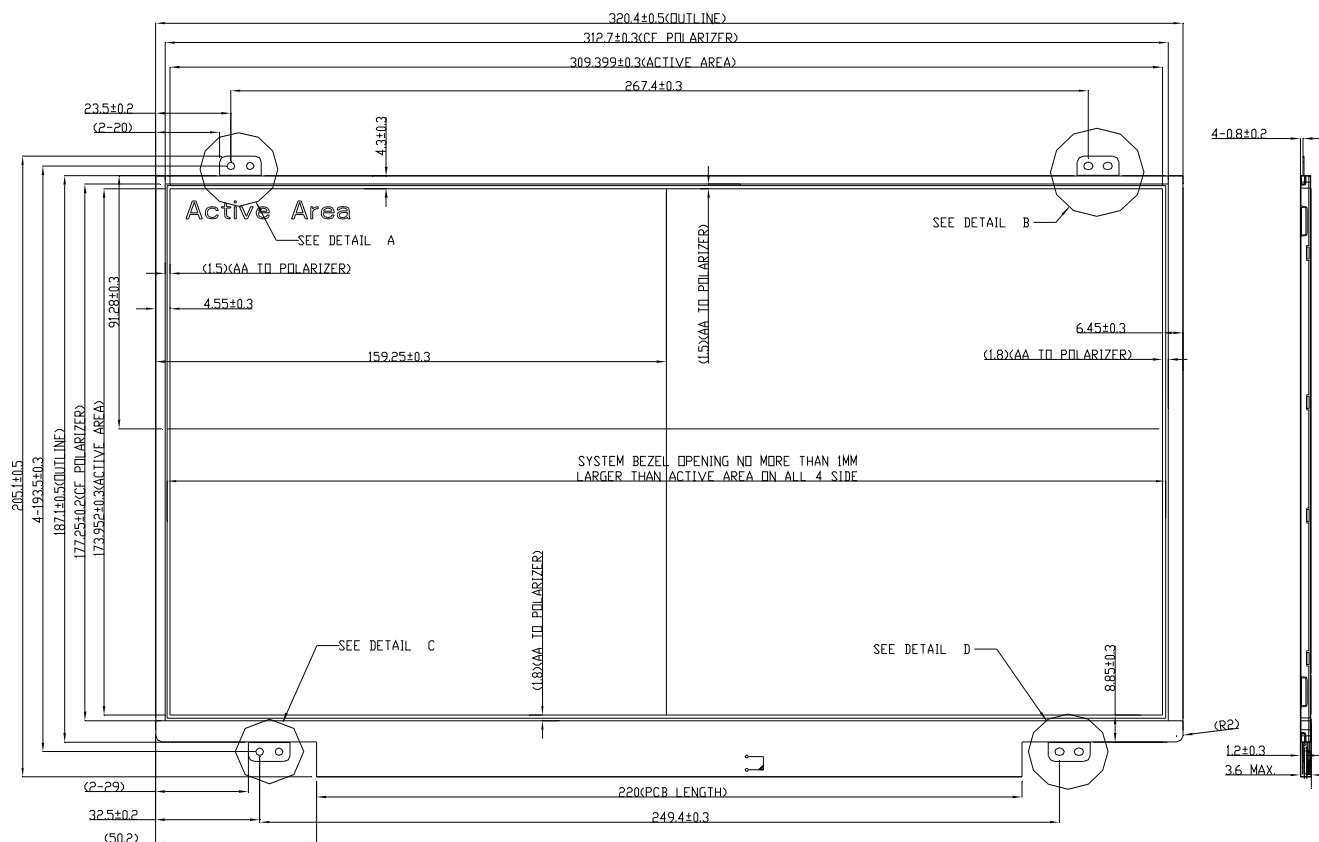
41	29	Standard timing ID # 2	01	00000001
42	2A	Standard timing ID # 3	01	00000001
43	2B	Standard timing ID # 3	01	00000001
44	2C	Standard timing ID # 4	01	00000001
45	2D	Standard timing ID # 4	01	00000001
46	2E	Standard timing ID # 5	01	00000001
47	2F	Standard timing ID # 5	01	00000001
48	30	Standard timing ID # 6	01	00000001
49	31	Standard timing ID # 6	01	00000001
50	32	Standard timing ID # 7	01	00000001
51	33	Standard timing ID # 7	01	00000001
52	34	Standard timing ID # 8	01	00000001
53	35	Standard timing ID # 8	01	00000001
54	36	Detailed timing description # 1 Pixel clock ("69.3MHz", According to VESA CVT Rev1.1)	12	00010010
55	37	# 1 Pixel clock (hex LSB first)	1B	00011011
56	38	# 1 H active ("1366")	56	01010110
57	39	# 1 H blank ("100")	64	01100100
58	3A	# 1 H active : H blank ("1366 : 100")	50	01010000
59	3B	# 1 V active ("768")	00	00000000
60	3C	# 1 V blank ("20")	14	00010100
61	3D	# 1 V active : V blank ("768 :20")	30	00110000
62	3E	# 1 H sync offset ("48")	30	00110000
63	3F	# 1 H sync pulse width ("32")	20	00100000
64	40	# 1 V sync offset : V sync pulse width ("1 : 4")	14	00010100
65	41	# 1 H sync offset : H sync pulse width : V sync offset : V sync width ("48: 32 : 1 : 4")	00	00000000
66	42	# 1 H image size ("309 mm")	35	00110101
67	43	# 1 V image size ("174 mm")	AE	10101110
68	44	# 1 H image size : V image size ("309 : 174")	10	00010000
69	45	# 1 H boarder ("0")	00	00000000
70	46	# 1 V boarder ("0")	00	00000000
71	47	# 1 Non-interlaced, Normal, no stereo, Separate sync, H/V pol Negatives	18	00011000
72	48	Detailed timing description # 2	00	00000000
73	49	# 2 Flag	00	00000000
74	4A	# 2 Reserved	00	00000000
75	4B	# 2 FE (hex) defines ASCII string (Model Name "N140BGE-L32", ASCII)	FE	11111110
76	4C	# 2 Flag	00	00000000
77	4D	# 2 1st character of name ("N")	4E	01001110
78	4E	# 2 2nd character of name ("1")	31	00110001
79	4F	# 2 3rd character of name ("4")	34	00110100
80	50	# 2 4th character of name ("0")	30	00110000
81	51	# 2 5th character of name ("B")	42	01000010
82	52	# 2 6th character of name ("G")	47	01000111
83	53	# 2 7th character of name ("E")	45	01000101
84	54	# 2 8th character of name ("-")	2D	00101101

## PRODUCT SPECIFICATION

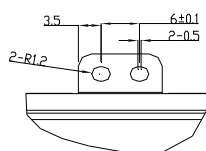
85	55	# 2 9th character of name ("L")	4C	01001100
86	56	# 2 9th character of name ("3")	33	00110011
87	57	# 2 Ath character of name ("2")	32	00110010
88	58	# 2 New line character indicates end of ASCII string	0A	00001010
89	59	# 2 Padding with "Blank" character	20	00100000
90	5A	Detailed timing description # 3	00	00000000
91	5B	# 3 Flag	00	00000000
92	5C	# 3 Reserved	00	00000000
93	5D	# 3 FE (hex) defines ASCII string (Vendor "INX", ASCII)	FE	11111110
94	5E	# 3 Flag	00	00000000
95	5F	# 3 1st character of string ("C")	43	01000011
96	60	# 3 2nd character of string ("M")	4D	01001101
97	61	# 3 3rd character of string ("N")	4E	01001110
98	62	# 3 New line character indicates end of ASCII string	0A	00001010
99	63	# 3 Padding with "Blank" character	20	00100000
100	64	# 3 Padding with "Blank" character	20	00100000
101	65	# 3 Padding with "Blank" character	20	00100000
102	66	# 3 Padding with "Blank" character	20	00100000
103	67	# 3 Padding with "Blank" character	20	00100000
104	68	# 3 Padding with "Blank" character	20	00100000
105	69	# 3 Padding with "Blank" character	20	00100000
106	6A	# 3 Padding with "Blank" character	20	00100000
107	6B	# 3 Padding with "Blank" character	20	00100000
108	6C	Detailed timing description # 4	00	00000000
109	6D	# 4 Flag	00	00000000
110	6E	# 4 Reserved	00	00000000
111	6F	# 4 FE (hex) defines ASCII string (Model Name"N140BGE-L32", ASCII)	FE	11111110
112	70	# 4 Flag	00	00000000
113	71	# 4 1st character of name ("N")	4E	01001110
114	72	# 4 2nd character of name ("1")	31	00110001
115	73	# 4 3rd character of name ("4")	34	00110100
116	74	# 4 4th character of name ("0")	30	00110000
117	75	# 4 5th character of name ("B")	42	01000010
118	76	# 4 6th character of name ("G")	47	01000111
119	77	# 4 7th character of name ("E")	45	01000101
120	78	# 4 8th character of name ("-")	2D	00101101
121	79	# 4 9th character of name ("L")	4C	01001100
122	7A	# 4 9th character of name ("3")	33	00110011
123	7B	# 4 Ath character of name ("2")	32	00110010
124	7C	# 4 New line character indicates end of ASCII string	0A	00001010
125	7D	# 4 Padding with "Blank" character	20	00100000
126	7E	Extension flag	00	00000000
127	7F	Checksum	09	00001001

# PRODUCT SPECIFICATION

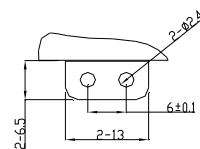
## Appendix. OUTLINE DRAWING



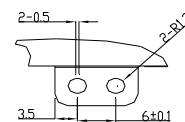
DETAIL A  
SCALE 2:1



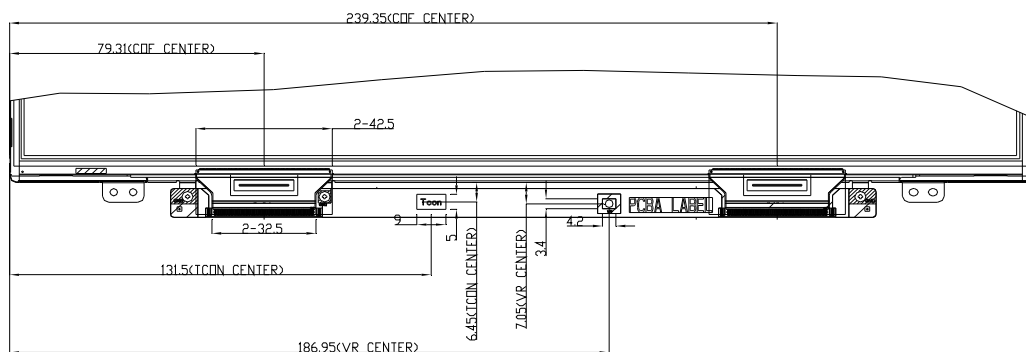
DETAIL B  
SCALE 2:1



DETAIL C  
SCALE 2:1

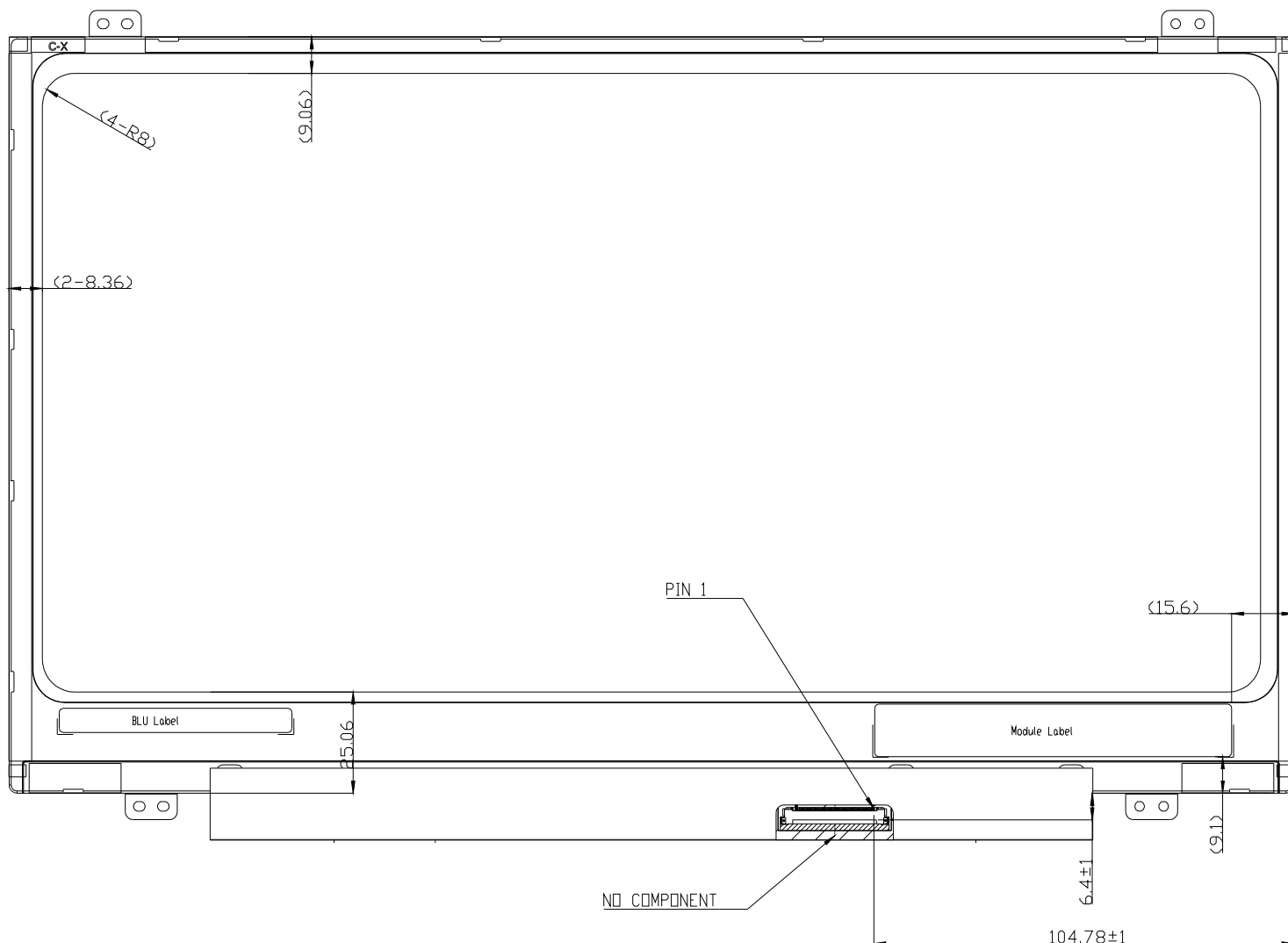


DETAIL D  
SCALE 2:1



COF, TCON AND VR LOCATIONS  
SEE NOTES FOR EXPLANATION

# PRODUCT SPECIFICATION



## NOTES:

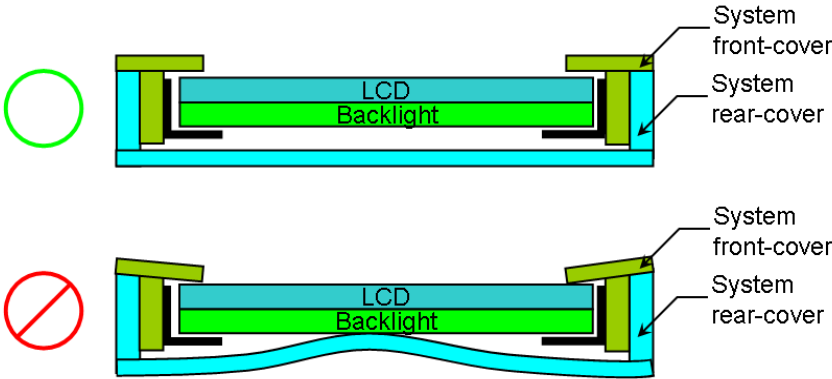
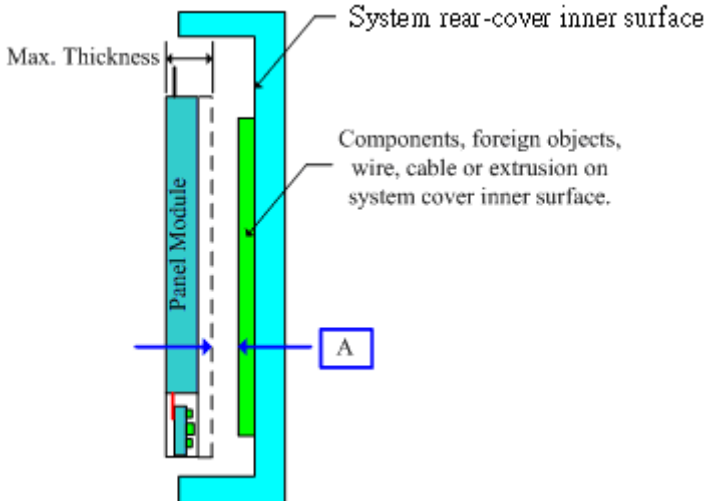
1. LCD MODULE INPUT CONNECTOR : I-PEX 20455-040E-12
2. IN ORDER TO AVOID ABNORMAL DISPLAY, POOLING AND WHITE SPOT,  
NO OVERLAPPING IS SUGGESTED AT CABLES, ANTENNAS, CAMERA,  
WLAN, WAN OR  
FOREIGN OBJECTS OVER COF, T-CON AND VR LOCATIONS.
3. LVDS CONNECTOR IS MEASURED AT PIN1 AND ITS MATING LINE.
4. MODULE FLATNESS SPEC 0.5mm MAX.
5. "< >" MARKS THE REFERENCE DIMENSIONS.

General Tolerance Unless Specified			
0-6	$\pm 0.1$	300-600	$\pm 0.3$
6-30	$\pm 0.15$	600-	$\pm 0.6$
30-300	$\pm 0.2$	ANGLE	$\pm 1.0^\circ$

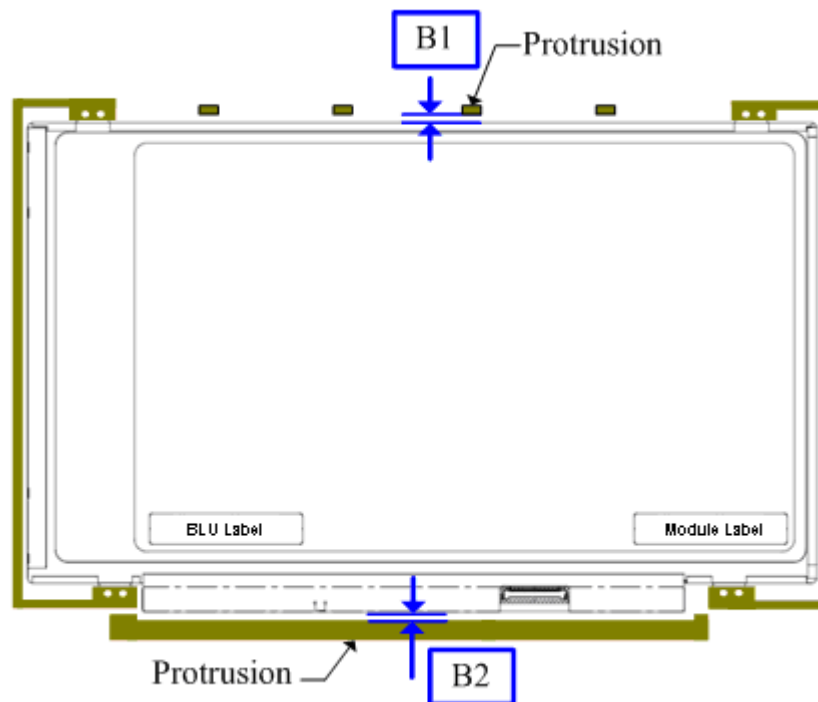


# PRODUCT SPECIFICATION

## Appendix. SYSTEM COVER DESIGN GUIDANCE

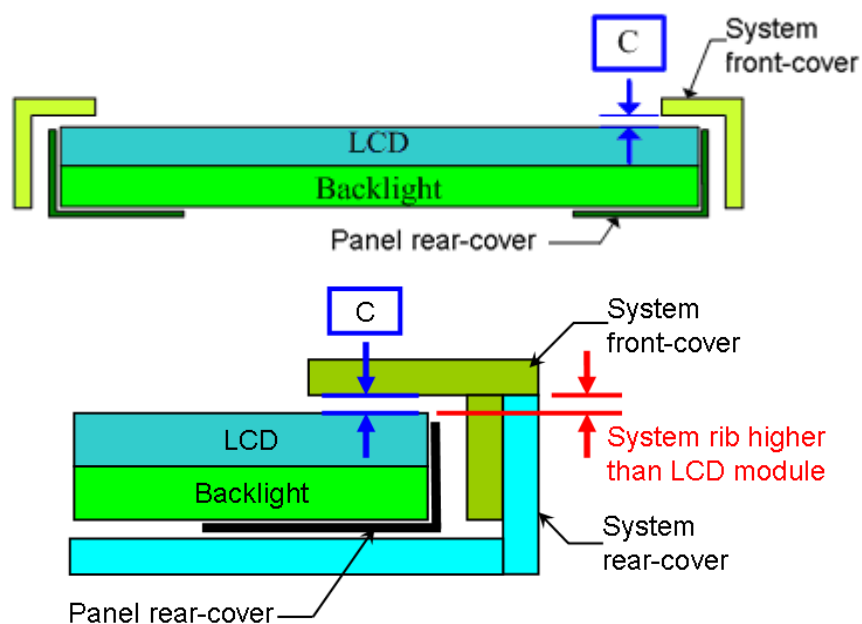
0.	Permanent deformation of system cover after reliability test
	
Definition	System cover including front and rear cover may deform during reliability test. Permanent deformation of system front and rear cover after reliability test should not interfere with panel. Because it may cause issues such as pooling, abnormal display, and also white spot.
1.	Design gap A between panel & any components on system rear-cover
	
Definition	<p>a). Sufficient gap between panel &amp; system is recommended for preventing from backpack or pogo test fail.</p> <p>b). Zero gap from panel's maximum thickness boundary to any components, foreign objects, wire, cable or extrusion on system cover inner surface is forbidden.</p> <p>c). Interference between panel and system rear-cover is forbidden after reliability test.</p> <p>Note: Recommend at least 0.6mm gap. If the gap is less than recommendation, please check with INX.</p>
2	Design gap B1 & B2 between panel & protrusions

## PRODUCT SPECIFICATION



Definition	<p>a). Sufficient gap is recommended between panel &amp; protrusions for preventing from shock related failures.</p> <p>b). Interference between panel and system rear-cover is forbidden after reliability test.</p> <p>Note: Recommend at least 2.0mm gap. If the gap is less than recommendation, please check with INX.</p>
------------	---

### 3 Design gap C between system front-cover & panel surface.

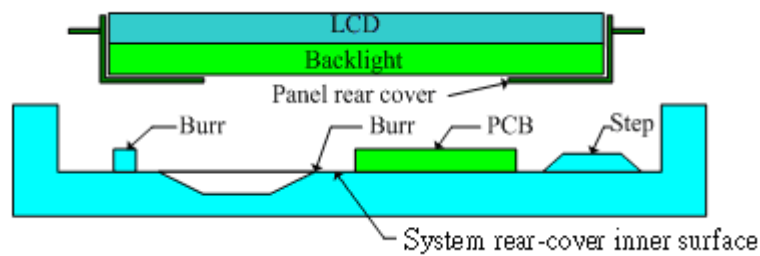


Definition	<p>a). Sufficient gap between system front-cover &amp; panel surface is a must for preventing from pooling or glass broken.</p> <p>b). Interference between panel and system (front &amp; rear) cover is forbidden after reliability</p>
------------	--

# PRODUCT SPECIFICATION

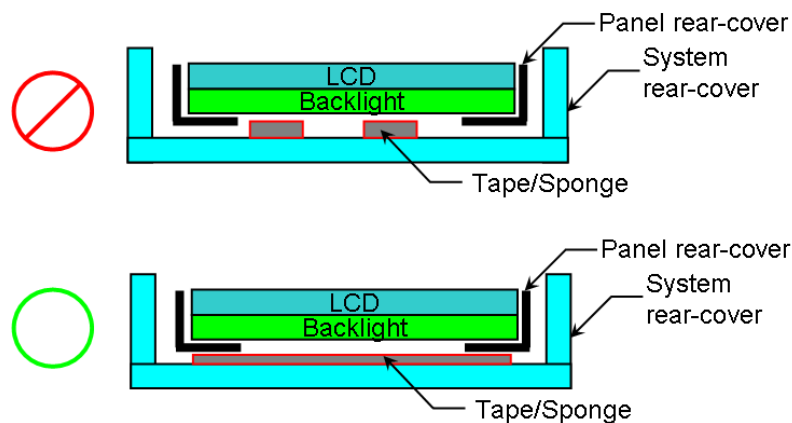
	<p>test.</p> <p>c). Interference is also forbidden in the act of system front-cover deformation during swing test, hinge test, knock test, or during pooling inspection procedure.</p> <p>d). To remain sufficient gap, design with system rib higher than maximum panel thickness is recommended.</p> <p>Note: Recommend at least 0.1mm gap. If the gap is less than recommendation, please check with INX.</p>
4	<p><b>Design gap D1 &amp; D2 between system front-cover &amp; PCB Assembly.</b></p> <div data-bbox="405 557 1219 799" data-label="Image"> </div>
Definition	<p>a). Sufficient gap between system front-cover &amp; PCB assembly is a must for preventing from abnormal display after backpack test, hinge test, twist test or pogo test.</p> <p>b). Interference between panel and system front-cover is forbidden after reliability test.</p> <p>c). Interference is also forbidden in the act of system front-cover deformation during swing test, hinge test, knock test, or during pooling inspection procedure.</p> <p>d). To remain sufficient gap, design with system rib higher than maximum panel thickness is recommended.</p> <p>Note: Recommend for D1 at least 0.1mm gap, D2 at least 2.0mm gap. If the gap is less than recommendation, please check with INX.</p>
5	<p><b>Interference examination of antenna cable and WebCam wire</b></p> <div data-bbox="438 1207 1147 1691" data-label="Image"> </div>
Definition	<p>a). Antenna cable or WebCam wire overlap with panel outline is forbidden for preventing from abnormal display &amp; white spot after backpack test, hinge test, twist test or pogo test.</p> <p>b). Antenna cable or WebCam wire bypass panel outline is recommended.</p> <p>c). Interference between panel and system rear-cover is forbidden after reliability test.</p>
6	<p><b>System rear-cover inner surface examination</b></p>

## PRODUCT SPECIFICATION



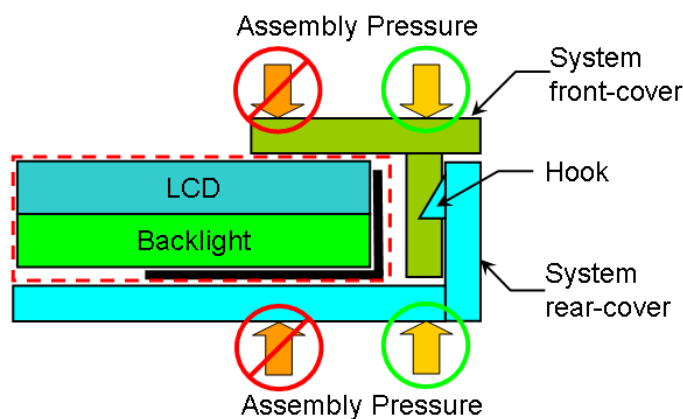
Definition	<p>a). Burr at logo edge, step, protrusion or PCB board will easily cause white spot or glass broken.</p> <p>b). Keeping flat surface underneath backlight is recommended.</p> <p>c). Interference between panel and system cover is forbidden after reliability test.</p>
------------	--

### 7 Tape/sponge design on system inner surface



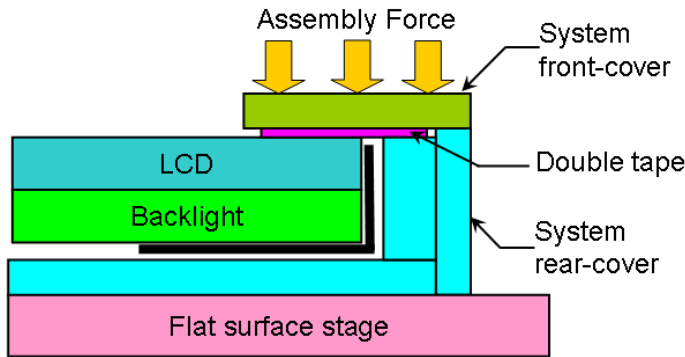
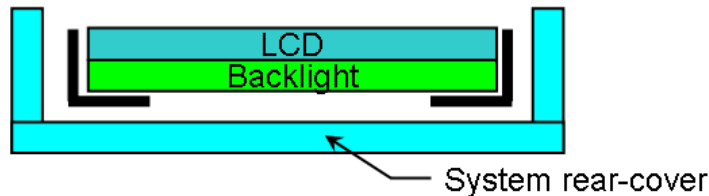
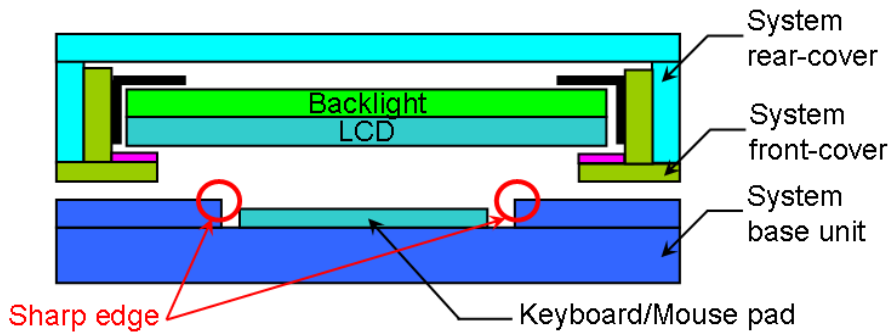
Definition	<p>a) To prevent abnormal display &amp; white spot after scuffing test, hinge test, pogo test, backpack test, it is not recommended to add tape/sponge in separate location. Since each tape/sponge may act as pressure concentration location.</p> <p>b) We suggest to design with a tape/sponge that well covered under panel rear-cover.</p> <p>c). Interference between panel and system rear-cover is forbidden after reliability test.</p>
------------	--

### 8 Assembly SOP examination

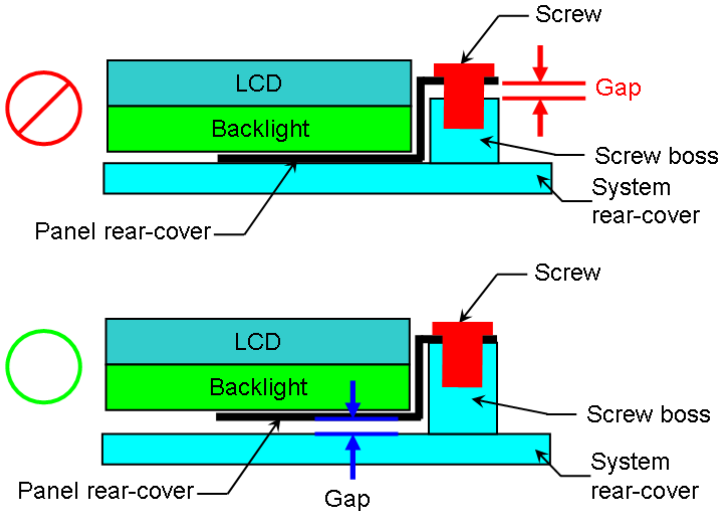


Definition	To prevent panel crack during system front-cover assembly process with hook design, it is prohibited to press panel or any location that related directly to the panel.
------------	---

# PRODUCT SPECIFICATION

9	<b>Assembly SOP examination</b>
 <p>The diagram illustrates the assembly process for the system front-cover. It shows a cross-section of the assembly with the following components and forces:</p> <ul style="list-style-type: none"> <li><b>Assembly Force:</b> Indicated by three yellow arrows pointing downwards onto the system front-cover.</li> <li><b>System front-cover:</b> The topmost component being assembled.</li> <li><b>Double tape:</b> A layer of adhesive tape between the front-cover and the LCD.</li> <li><b>LCD:</b> The liquid crystal display panel.</li> <li><b>Backlight:</b> The light source for the LCD.</li> <li><b>System rear-cover:</b> The bottom component of the system.</li> <li><b>Flat surface stage:</b> The base on which the assembly is performed.</li> </ul>	
Definition	To prevent panel crack during system front-cover assembly process without hook design, it is only allowed to give slight pressure with large contact area. This can help to distribute the stress and prevent stress concentration. Also it is suggest to put the system on a flat surface stage during the assembly.
10	<b>Material used for system rear-cover</b>
 <p>The diagram shows a cross-section of the system rear-cover assembly. It includes the following components:</p> <ul style="list-style-type: none"> <li><b>LCD:</b> The liquid crystal display panel.</li> <li><b>Backlight:</b> The light source for the LCD.</li> <li><b>System rear-cover:</b> The bottom component of the system.</li> </ul>	
Definition	<p>a) To prevent abnormal display &amp; white spot after scuffing test, hinge test, pogo test, backpack test, as the poor rigidity result from deformation of system rear-cover during the test.</p> <p>b) We suggest using aluminum-magnesium alloy as the system rear-cover material with thickness min 1.5mm, instead of using PC/ABS.</p>
11	<b>System base unit design near keyboard and mouse pad</b>
 <p>The diagram illustrates the design of the system base unit near the keyboard and mouse pad. It shows the following components and design considerations:</p> <ul style="list-style-type: none"> <li><b>System rear-cover:</b> The top component of the system.</li> <li><b>System front-cover:</b> The bottom component of the system.</li> <li><b>System base unit:</b> The base of the system.</li> <li><b>Keyboard/Mouse pad:</b> The input device.</li> <li><b>Sharp edge:</b> A red circle highlights a sharp edge on the system base unit, indicating a design flaw that should be avoided.</li> </ul>	
Definition	To prevent abnormal display & white spot after scuffing test, hinge test, pogo test, backpack test, no sharp edge design is allowed in any area that may damage the panel during the test. We suggest to remove all sharp edges, or to reduce the thickness difference of keyboard/mouse pad from the nearby surface.
12	<b>Screw boss height design</b>

## PRODUCT SPECIFICATION

	 <p>The diagrams illustrate the required gap between the panel rear-cover bracket and the screw boss surface. The top diagram, marked with a red prohibition symbol, shows a gap between the panel rear-cover bracket and the screw boss surface, which is labeled as prohibited. The bottom diagram, marked with a green circle, shows a sufficient gap between the panel and the system rear-cover, indicating a correct design. Labels include: LCD, Backlight, Panel rear-cover, Screw, Screw boss, System rear-cover, and Gap.</p>
<p>Definition</p>	<p>a). Gap left between panel rear-cover bracket and screw boss surface is prohibited.  b). To remain sufficient gap between panel and system rear-cover, screw boss height must be designed with respect to the height of bracket bottom surface to panel bottom surface + flatness change of panel itself.</p>